8-bit Proprietary Microcontroller

CMOS

F²MC-8L MB89560A Series

MB89567A/567AC/P568/PV560

■ DESCRIPTION

The MB89560A series has been developed as a general-purpose version of the F²MC*1-8L family consisting of proprietary 8-bit, single-chip microcontrollers.

In addition to a compact instruction set, the microcontroller contains a variety of peripheral functions such as I²C interface*2, timers, 2 ch 8-bit PWM timers, 8/16-bit timer, 21-bit timebase timer, 8-bit PWC timer, 17-bit Watch prescaler, Watch-dog timer, High speed UART, 8-bit SIO, UART/SIO, LCD controller/driver (optional booster), Two type Programmable Pulse Generators (PPG), an A/D converter, and external interrupt.
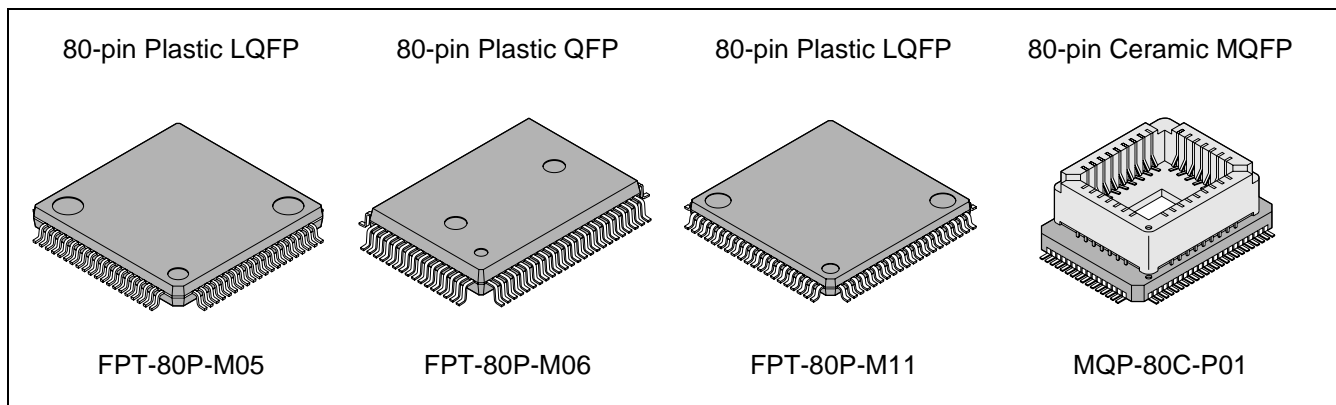
*1 : F²MC stands for FUJITSU Flexible Microcontroller.
*2 : I²C of this product is complied to Intel Corp. System Management Bus Rev. 1.0 specification and to the Philips I²C specification.

■ FEATURES

- F²MC-8L family CPU core
- Low-voltage operation (when an A/D converter is not used)
- Low current consumption (applicable to the dual-clock system)
- Minimum execution time: 0.32 μs at 12.5 MHz /3.5 V to 5.5 V

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■ PACKAGES

| 80-pin Plastic LQFP | 80-pin Plastic QFP | 80-pin Plastic LQFP | 80-pin Ceramic MQFP |
| FPT-80P-M05 | FPT-80P-M06 | FPT-80P-M11 | MQP-80C-P01 |

FUJITSU

(Continued)
- I²C interface circuit
- LCD controller/driver: 24 segments x 4 commons (Max 96 pixels, duty LCD mode and Static LCD mode)
- LCD booster function (option)
- Wild register (Max 6 different address locations)
- 10-bit A/D converter: 8 channels
- Three types of Serial Interface:
    High Speed UART (Transfer rate from 300 bps to 192000 bps /10 MHz main clock)
    8-bit Serial I/O (SIO)
    UART/SIO
- Two type of Programmable Pulse Generator(PPG): 6-bit PPG and 12-bit PPG
- Six types of timer
    8-bit PWM 2 channels timers
    8/16-bit timer/counter (8 bits x 2 channels or 16 bits x 1 channel)
    21-bit timebase timer
    8-bit PWC timer operation
    17-bit Watch prescaler
    Watch-dog timer
- I/O ports: Max 50 channels
- External interrupt 1: 8 channels
- External interrupt 2 (wake-up function): 4 channels
- Low-power consumption modes (stop mode, sleep mode, and watch mode)
- LQFP-80 and QFP-80 package
- CMOS technology

■ PRODUCT LINEUP

Part number / Parameter	MB89567A	MB89567AC	MB89P568	MB89PV560
Classification	Mass production products (mask ROM products)		OTP	Piggy-back
ROM size	32 K x 8-bit (internal mask ROM)		48 K x 8-bit (internal PROM)	56 K x 8-bit (external ROM)
RAM size	1 K x 8-bit			1 K x 8-bit
CPU functions	Number of instructions : 136 Instruction bit length : 8-bit Instruction length : 1 to 3 bytes Data bit length : 1-, 8-, 16-bit Minimum execution time : 0.32 μs/12.5 MHz Minimum interrupt processing time : 2.88 μs/12.5 MHz			
Ports	General-purpose I/O ports (N-channel open drain): 20 pins (2 shared with I^2C inputs, 16 shared with LCD, 2 shared with other resources) General-purpose I/O ports (CMOS) : 30 pins (shared with resources) Total : 50 pins			
21-bit timebase timer	21-bit Interrupt cycle: $(2^{13}, 2^{15}, 2^{18}$ or $2^{22})/F_{CH}$*7			
Watchdog timer	Reset generate cycle: Min $2^{21}/F_{CH}$*7 for main clock, Min $2^{14}/F_{CL}$*7 for sub clock			
Watch prescaler	17-bit Interrupt cycle: 31.25 ms, 0.25 s, 0.50 s, 1.00 s, 2.00 s, 4.00 s/32.768 kHz for subclock			
8/16-bit timer/counter	Can be operated either as a 2-channel 8-bit timer/counter (Timer 1 and Timer 2, each with its own independent operating clock cycle), or as one 16-bit timer/counter In Timer 1 or 16-bit timer/counter operation, event counter operation (external clock-triggered) and square wave output capable			
8-bit PWM 2 ch timer	8-bit interval timer operation (square wave output capable, operating clock cycle: 1 t_{inst}, 8 t_{inst}, 16 t_{inst}, 64 t_{inst}) 8-bit resolution PWM operation (conversion cycle: 128 x 1 t_{inst} to 256 x 64 t_{inst}) 8/16-bit timer/counter output for counter clock selectability			
PWC timer	8-bit timer operation (count clock cycle: 1 t_{inst}, 4 t_{inst}, 32 t_{inst}) 8-bit reload timer operation (toggle output possible, operating clock cycle: 1 to 32 t_{inst}) 8-bit pulse width measurement (continuous measurement possible: H-width, L-width, rising edge to rising edge, falling edge to falling edge, and rising edge to falling edge)			
10-bit A/D converter *2	10-bit resolution × 8 channels A/D conversion function (conversion time: 60 t_{inst}) Continuous activation by an 8/16-bit timer/counter output or a timebase timer output capable.			
6-bit PPG	Internal 6-bit counter Pulse width and cycle are program selectable			
12-bit PPG	Internal 12-bit counter Pulse width and cycle are program selectable			

(Continued)

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(Continued)

Part number Parameter	MB89567A	MB89567AC	MB89P568	MB89PV560
I^{2}C interface*4	Not Available	1 channel		
High speed UART	Transfer data length: 4-, 6-, 7-, 8-bit Transfer rate (300 bps to 192000 bps /9.216 MHz main clock) support sub-clock mode			
UART/SIO	Transfer data length: 7-, 8-bit for UART, 8-bit for SIO Transfer rate (1201 bps to 78125 bps / 10 MHz main clock) support sub-clock mode			
8-bit serial I/O	8-bit, LSB first/MSB first selectability Transfer clocks (one external shift clock, three internal shift clocks: 2 t_{inst}, 8 t_{inst}, 32 t_{inst}) *5			
LCD	Common output: 4 (Max) Segment output: 24 (Max) LCD driving power (bias) pins: 4 LCD display RAM size: 12 bytes (24 × 4 bits, Max 96 pixels) Duty LCD mode and Static LCD mode Booster for LCD driving: option*1 Dividing resistor for LCD driving: option			
Wild register	Maximum of 6-byte data can be assigned in 6 different address. Used to replace any data in the ROM when specific address and data are assigned in Wild register. Wild register can be set up by using different communication methods through the device.			
External interrupt 1 (wake-up function)	8 independent channels (interrupt vector, request flag, request output enable) Edge selectability (rising/falling) Used also for wake-up from stop/sleep mode. (edge detection is also permitted in stop mode.)			
External interrupt 2 (wake-up function)	4 channels ("L" level interrupts, independent input enable). Used also for wake-up from stop/sleep mode. (Low-level detection is also permitted in stop mode.)			
Standby mode	Sub clock mode, sleep mode, stop mode and clock mode			
Process	CMOS			
Operating voltage *6	2.2 V to 5.5 V		2.7 V to 5.5 V	2.7 V to 5.5 V*3

*1 : When booster is used, the bias is reduced by 1/3. It can be selected by mask option.

*2 : Voltage varies with product.

*3 : When external ROM is used, EPROM: MBM27C512-20 should be used, the operating voltage: 4.5 V to 5.5 V.

*4 : I^{2}C is complied to Intel Corp. System Management Bus Rev. 1.0 specification and to the Philips I^{2}C specification.

*5 : 1 t_{inst} = one instruction cycle (execution time) which can be selected as 1/4, 1/8, 1/16, or 1/64 of main clock if main clock mode is selected, or 1/2 of the subclock if subclock mode is selected.

*6 : Varies with conditions such as the operating frequency. (See "■ELECTRICAL CHARACTERISTICS.")

*7 : F_{CH} : main clock source oscillation, F_{CL} : sub clock source oscillation

■ PACKAGE AND CORRESPONDING PRODUCTS

Package	MB89567A MB89567AC	MB89P568-101 MB89P568-102	MB89PV560-101 MB89PV560-102
FPT-80P-M05	○	○	✕
FPT-80P-M06	○	○	✕
FPT-80P-M11	○	○	✕
MQP-80C-P01	✕	✕	○

■ DIFFERENCES AMONG PRODUCTS

1. Memory Size

Before evaluating using the OTPROM (one-time PROM) products, verify its differences from the product that will actually be used. Take particular care on the following points:
• The stack area, etc., is set at the upper limit of the RAM.

2. Current Consumption
• For the MB89PV560, add the current consumed by the EPROM mounted in the piggy-back socket.
• When operating at low speed, the current consumed by the one-time PROM product is greater than that for the mask ROM product. However, the current consumption is roughly the same in sleep or stop mode.
• For more information, see "■ ELECTRICAL CHARACTERISTICS."

3. Mask Options

The functions available as options and the method of specifying options differ between products.
Before using options check "■ MASK OPTIONS."

4. Wild register function

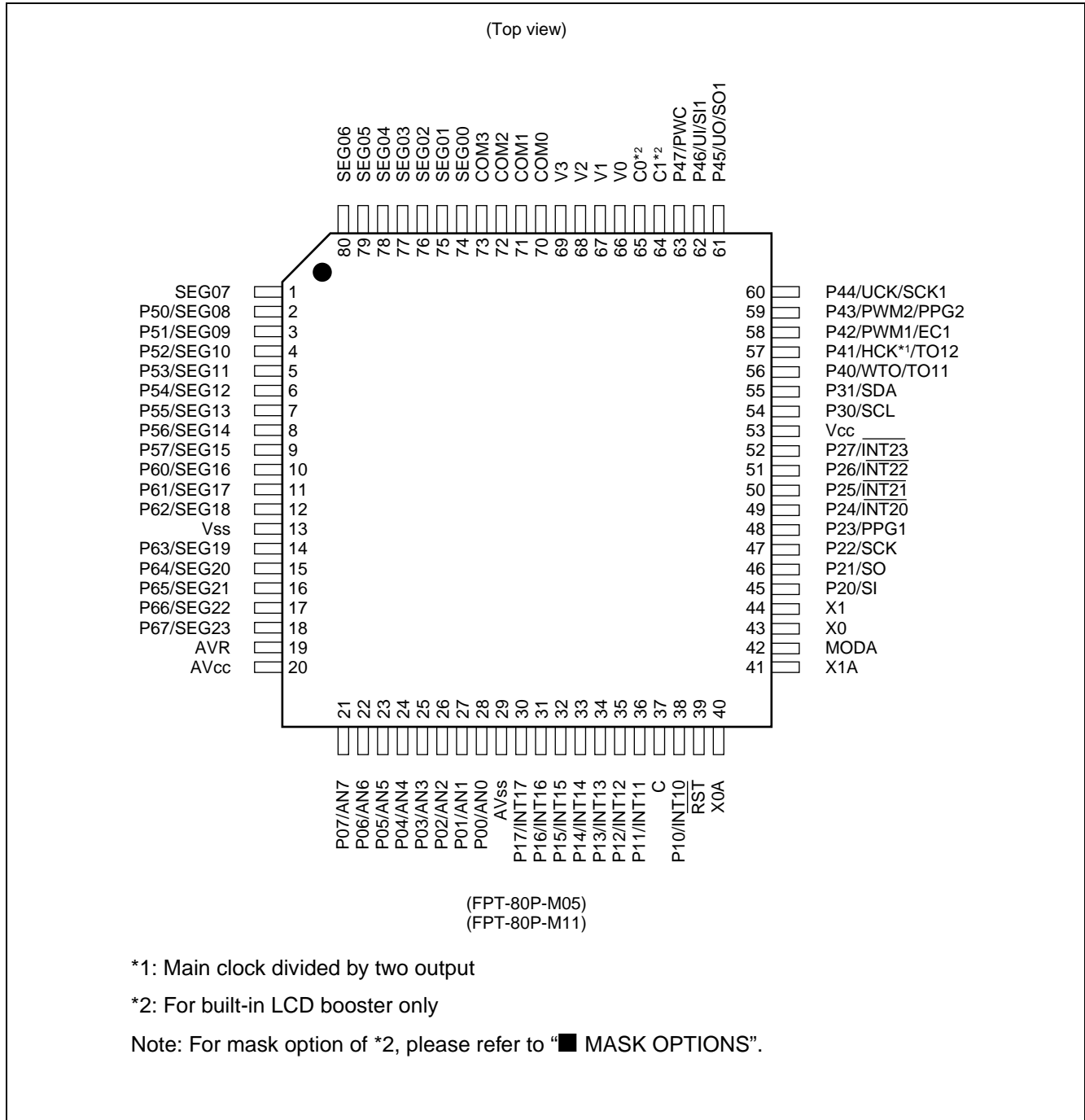The Wild Register can be used in the following address spaces.

Device	Address Space
MB89PV560	4000_H to $FFFF_H$
MB89P568	4000_H to $FFFF_H$
MB89567A/567AC	8000_H to $FFFF_H$

5. P40, P41

It will take about 64 count clock of external oscillation to initialize P40 and P41 pins in MB89PV560/P568. Therefore, these ports will be unstable for a while during power-on. For MB89567A/567AC, these ports will be in High-Z during power-on.

■ PIN ASSIGNMENT

(Top view)

Top pins (80 → 61): SEG06, SEG05, SEG04, SEG03, SEG02, SEG01, SEG00, COM3, COM2, COM1, COM0, V3, V2, V1, V0, CO*2, C1*2, P47/PWC, P46/UI/SI1, P45/UO/SO1

Left pins (1 → 20):
Pin	Signal
1	SEG07
2	P50/SEG08
3	P51/SEG09
4	P52/SEG10
5	P53/SEG11
6	P54/SEG12
7	P55/SEG13
8	P56/SEG14
9	P57/SEG15
10	P60/SEG16
11	P61/SEG17
12	P62/SEG18
13	Vss
14	P63/SEG19
15	P64/SEG20
16	P65/SEG21
17	P66/SEG22
18	P67/SEG23
19	AVR
20	AVcc

Right pins (60 → 41):
Pin	Signal
60	P44/UCK/SCK1
59	P43/PWM2/PPG2
58	P42/PWM1/EC1
57	P41/HCK*1/TO12
56	P40/WTO/TO11
55	P31/SDA
54	P30/SCL
53	Vcc
52	P27/INT23
51	P26/INT22
50	P25/INT21
49	P24/INT20
48	P23/PPG1
47	P22/SCK
46	P21/SO
45	P20/SI
44	X1
43	X0
42	MODA
41	X1A

Bottom pins (21 → 40): P07/AN7, P06/AN6, P05/AN5, P04/AN4, P03/AN3, P02/AN2, P01/AN1, P00/AN0, AVss, P17/INT17, P16/INT16, P15/INT15, P14/INT14, P13/INT13, P12/INT12, P11/INT11, C, P10/INT10, RST, X0A

(FPT-80P-M05)
(FPT-80P-M11)

*1: Main clock divided by two output

*2: For built-in LCD booster only

Note: For mask option of *2, please refer to "■ MASK OPTIONS".

(Continued)

(Top view)

(FPT-80P-M06)

*1: Main clock divided by two output

*2: For built-in LCD booster only

Note: For mask option of *2, please refer to "■ MASK OPTIONS".

(Continued)

(Top view)

(MQP-80C-P01)

*1: Main clock divided by two output
*2: For built-in LCD booster only
*3: Pin assignment on package top (MB89PV560 only)

Pin no.	Pin	Pin no.	Pin	Pin no.	Pin	Pin no.	Pin
81	N.C.	89	AD2	97	N.C.	105	$\overline{OE}$
82	A15	90	AD1	98	04	106	N.C.
83	A12	91	AD0	99	O5	107	A11
84	AD7	92	N.C.	100	O6	108	A9
85	AD6	93	O1	101	07	109	A8
86	AD5	94	O2	102	O8	110	A13
87	AD4	95	O3	103	$\overline{CE}$	111	A14
88	AD3	96	VSS	104	A10	112	VCC

N.C.: Internally connected. Do not use.

Note: For mask option of *2, please refer to "■ MASK OPTIONS".

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■ PIN DESCRIPTION

Pin no.		Pin name	I/O circuit type	Function
LQFP*1 LQFP*2	MQFP*3 QFP*4			
43	45	X0	A	Crystal or other resonator connector pins for the main clock. The external clock can be connected to X0. When this is done, be sure to leave X1 open.
44	46	X1		
42	44	MODA	C	Memory access mode setting pins. Connect directly to VSS. Hysteresis input type.
39	41	$\overline{RST}$	D	Reset I/O pin This pin is a CMOS output type with a pull-up resistor, and a hysteresis input type. "L" is output from this pin by an internal reset request (optional). The internal circuit is initialized by the input of "L".
49 to 52	51 to 54	P24/$\overline{INT20}$ to P27/$\overline{INT23}$	E	General-purpose CMOS I/O ports Also serve as an external interrupt 2 input (wake-up function). External interrupt 2 input is hysteresis input. Selectable pull-up resistor.
30 to 36, 38	32 to 38, 40	P10/INT10 to P17/INT17	E	General-purpose CMOS I/O ports Also serve as input for external interrupt 1 input. External interrupt 1 input is hysteresis input. Selectable pull-up resistor.
60	62	P44/UCK/ SCK1	E	General-purpose CMOS I/O ports Also serve as the clock I/O for the High-speed UART and Serial I/O. The peripheral is a hysteresis input type. Selectable pull-up resistor.
61	63	P45/UO/ SO1	F	General-purpose CMOS I/O ports Also serves as the data output for the High-speed UART and Serial I/O.
62	64	P46/UI/SI1	G	N-ch open drain general-purpose I/O ports Also serves as the data input for the High-speed UART and Serial I/O. The peripheral is a hysteresis input type.
63	65	P47/PWC	G	N-ch open drain general-purpose I/O port Also serve as the external clock input for PWC. The peripheral is a hysteresis input.
56	58	P40/WTO/ TO11	F	General-purpose CMOS I/O port Also serves as an 8/16-bit timer/counter output and PWC output.

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Pin no.		Pin name	I/O circuit type	Function
LQFP*1 LQFP*2	MQFP*3 QFP*4			
57	59	P41/HCK/ TO12	F	General-purpose CMOS I/O port Also serves as an 8/16-bit timer/counter output. and half of main clock output Selectable pull-up resistor.
45	47	P20/SI	E	General-purpose CMOS I/O port Also serves as the data input for the serial I/O. The peripheral is a hysteresis input type. Selectable pull-up resistor.
46	48	P21/SO	F	General-purpose CMOS I/O port Also serves as the data output for the serial I/O. Selectable pull-up resistor.
47	49	P22/SCK	E	General-purpose CMOS I/O port Also serves as the clock I/O for the serial I/O. The peripheral is a hysteresis input type. Selectable pull-up resistor.
48	50	P23/PPG1	F	General-purpose CMOS I/O port Also serves as the 6 bit PPG output pin. Selectable pull-up resistor.
54	56	P30/SCL	G	N-ch open-drain general-purpose I/O port Clock I/O pin for I^{2}C interface
55	57	P31/SDA	G	N-ch open-drain general-purpose I/O port Data I/O pin for I^{2}C interface
65	67	C0	—	Function as capacitor connection pin in the products with a booster.
64	66	C1		
59	61	P43/ PWM2/ PPG2	F	General-purpose CMOS I/O port Also serves PWM wave output for the 8-bit PWM timer 1 and as 12 bit programmable pulse generator output. Selectable pull-up resistor.
58	60	P42/ PWM1/ EC1	E	General-purpose CMOS I/O port Also serves as the PWM wave output and external clock for the 8/16 bit timer counter. Selectable pull-up resistor.
21 to 28	23 to 30	P00/AN0 to P07/AN7	J	General-purpose CMOS I/O ports Also serve as the analog input for the A/D converter. Selectable pull-up resistor.

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Pin no.		Pin name	I/O circuit type	Function
LQFP*1 LQFP*2	MQFP*3 QFP*4			
10 to 12 14 to 18	12 to 14 16 to 20	P60/ SEG16 to P67/ SEG23	H	N-ch open-drain general-purpose output ports Also serve as an LCD controller/driver segment output.
2 to 9	4 to 11	P50/SEG8 to P57/ SEG15	H	N-ch open-drain general-purpose output ports Also serve as an LCD controller/driver segment output.
74 to 80, 1	1 to 3 76 to 80	SEG0 to SEG7	I	LCD controller/driver segment output-only pins
70 to 73	72 to 75	COM0 to COM3	I	LCD controller/driver common output-only pins
66 to 69	68 to 71	V0 to V3	—	LCD driving power supply pins.
40	42	X0A	B	Crystal or other resonator connector pins for the subclock (Subclock: 32.768 kHz)
41	43	X1A		
53	55	Vcc	—	Power supply pin
37	39	C	—	Capacitor connection pin *5
13	15	Vss	—	Power supply (GND) pin
20	22	AVcc	—	A/D converter power supply pin
19	21	AVR	—	A/D converter reference voltage input pin
29	31	AVss	—	A/D converter power supply pin Use this pin at the same voltage as Vss.

*1: FPT-80P-M05

*2: FPT-80P-M11

*3: MQP-80C-P01

*4: FPT-80P-M06

*5: When MB89567A / MB89567AC / MB89PV560-101 / MB89PV560-102 is used, this pin will become NC pin without internal connection. There is no problem to leave pins open, to fix pins at Vcc and to fix pins at Vss. When MB89P568-101 or MB89P568-102 is used, this pin must be connected to Vss.

• For External EPROM Socket (MB89PV560 ONLY)

Pin no.	Pin name	I/O	Function
82 83 84 85 86 87 88 89 90 91	A15 A12 A7 A6 A5 A4 A3 A2 A1 A0	O	Address output pins
93 94 95	O1 O2 O3	I	Data input pins
96	Vss	O	Power supply (GND) pin
98 99 100 101 102	O4 O5 O6 O7 O8	I	Data input pins
103	$\overline{CE}$	O	ROM chip enable pin Outputs "H" during standby.
104	A10	O	Address output pin
105	$\overline{OE}/V_{pp}$	O	ROM output enable pin Outputs "L" at all times.
107 108 109	A11 A9 A8	O	Address output pins
110	A13	O	
111	A14	O	
112	Vcc	O	EPROM power supply pin
81 92 97 106	N.C.	—	Internally connected pins Be sure to leave them open.
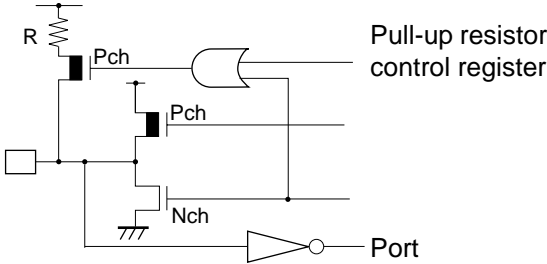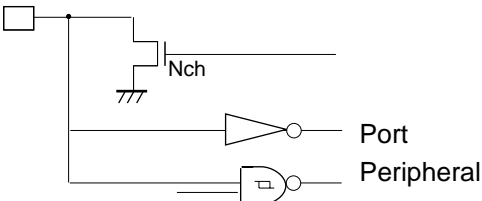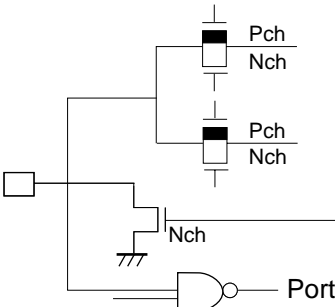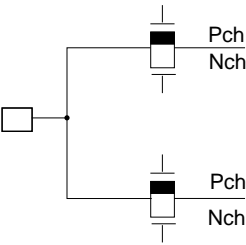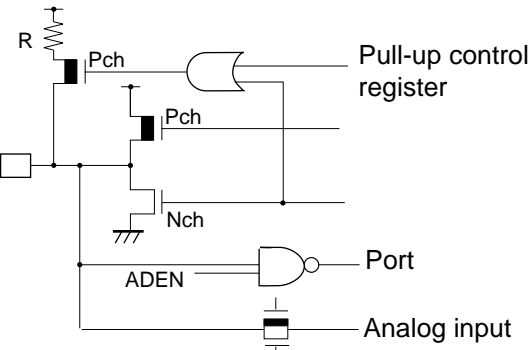
■ I/O CIRCUIT TYPE

Type	Circuit	Remarks
A	 X1 Nch Pch Pch X0 Nch Main clock control signal	Main clock (main clock crystal oscillator) • At an oscillation feedback resistor of approximately 1 MΩ/5.0 V
B	 X1A Nch Pch X0A Nch Sub clock control signal	Subclock (subclock crystal oscillator) • At an oscillation feedback resistor of approximately 4.5 MΩ/5.0 V
C		• Hysteresis input
D	 R Pch Nch	• CMOS output • Hysteresis input • At an output pull-up resistor (P-ch) of approximately 50 kΩ/5.0 V
E	 R Pch Pch Nch Pull-up control register Port Peripheral	• CMOS output • CMOS input • The peripheral is a hysteresis input type. • Selectable pull-up resistor (P-ch) of approximately 50 kΩ/5.0 V

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Type	Circuit	Remarks
F	Pull-up resistor control register / Port	• CMOS output • CMOS input • Selectable pull-up resistor (P-ch) of approximately 50 kΩ/5.0 V
G	Port / Peripheral	• N-ch open-drain input/output • CMOS input • The peripheral is a hysteresis input type. (P30,P31 are OR-type input for I^{2}C)
H	Port	• N-ch open-drain output • CMOS input • LCD controller/driver segment output
I		• LCD controller/driver common/segment output
J	Pull-up control register / Port / Analog input	• General CMOS I/O • Analog input (A/D converter) • Selectable pull-up resistor (P-ch) of approximately 50 kΩ/5.0 V • Pull-up resistors must be disabled when used as an analog input.

■ HANDLING DEVICES

1. Preventing Latchup

Latchup may occur on CMOS ICs if voltage higher than V_{CC} or lower than V_{SS} is applied to input and output pins other than medium- to high-voltage pins or if higher than the voltage which shows on "1. Absolute Maximum Ratings" in "■ ELECTRICAL CHARACTERISTICS" is applied between V_{CC} and V_{SS}.

When latchup occurs, power supply current increases rapidly and might thermally damage elements. When using, take great care not to exceed the absolute maximum ratings.

Also, take care to prevent the analog power supply (AV_{CC} and AVR) and analog input from exceeding the digital power supply (V_{CC}) when the analog system power supply is turned on and off.

2. Treatment of Unused Input Pins

Leaving unused input pins open could cause malfunctions. They should be connected to a pull-up or pull-down resistor.

3. Treatment of Power Supply Pins on Microcontrollers with A/D and D/A Converters

Connect to be $AV_{CC} = DV_{CC} = V_{CC}$ and $AV_{SS} = AVR = V_{SS}$ even if the A/D and D/A converters are not in use.

4. Treatment of N.C. Pins

Be sure to leave (internally connected) N.C. pins open.

5. Power Supply Voltage Fluctuations

Although V_{CC} power supply voltage is assured to operate within the rated range, a rapid fluctuation of the voltage could cause malfunctions, even if it occurs within the rated range. Stabilizing voltage supplied to the IC is therefore important. As stabilization guidelines, it is recommended to control power so that V_{CC} ripple fluctuations (P-P value) will be less than 10% of the standard V_{CC} value at the commercial frequency (50 Hz to 60 Hz) and the transient fluctuation rate will be less than 0.1 V/ms at the time of a momentary fluctuation such as when power is switched.

6. Precautions when Using an External Clock

Even when an external clock is used, oscillation stabilization time is required for power-on reset and wake-up from stop mode.

7. Unused LCD dedicated pins

When LCD dedicated pins are not in use, keep it open.

8. Ports shared with SEG pin

When using port shared with SEG pin, be sure that the input voltage to port does not exceed the voltage of V3 (SEG driving voltage). This is particularly important to those devices with booster. When power-on or reset, SEG pin will output an initial value of "L".

9. LCD not in use

When LCD is not in use, connect the V3 pin to Vcc and keep other LCD dedicated pins open.

10. Wild Register function

In MB89PV560, wild register function cannot be evaluated. To evaluate the wild register function, use MB89P568.

11. Programming operation on RAM

Program operation debugging at RAM is not possible even when using MB89PV560.

12. Note to Noise in the External Reset Pin ($\overline{RST}$)

If the reset pulse applied to the external reset pin ($\overline{RST}$) does not meet the specifications, it may cause malfunctions. Use caution so that the reset pulse less than the specifications will not be fed to the external reset pin ($\overline{RST}$).

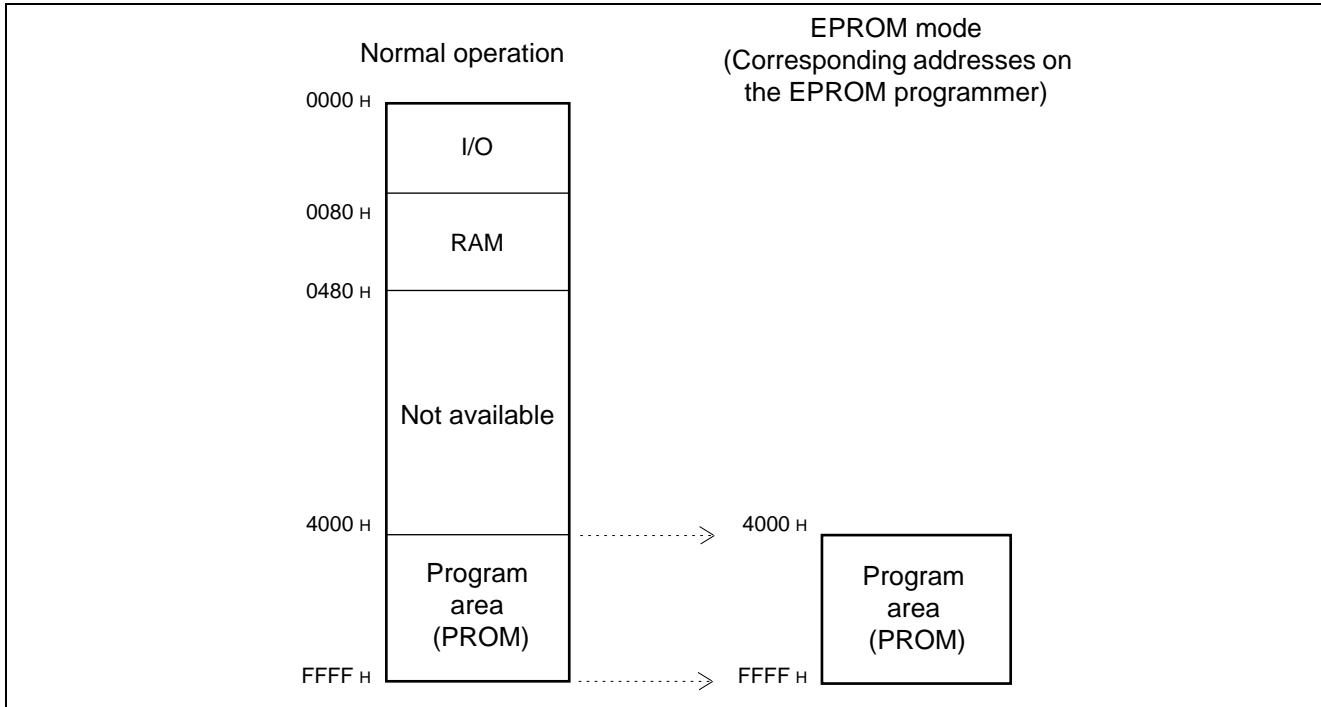## ■ PROGRAMMING TO THE EPROM ON THE MB89P568

The MB89P568 is an OTPROM version of the MB89567A and MB89567AC.

1.   Features
• 48-Kbyte PROM on chip
• Equivalency to the MBM27C1001 in EPROM mode (when programmed with the EPROM programmer)

2.   Memory Space

Memory space in EPROM mode is diagrammed below.
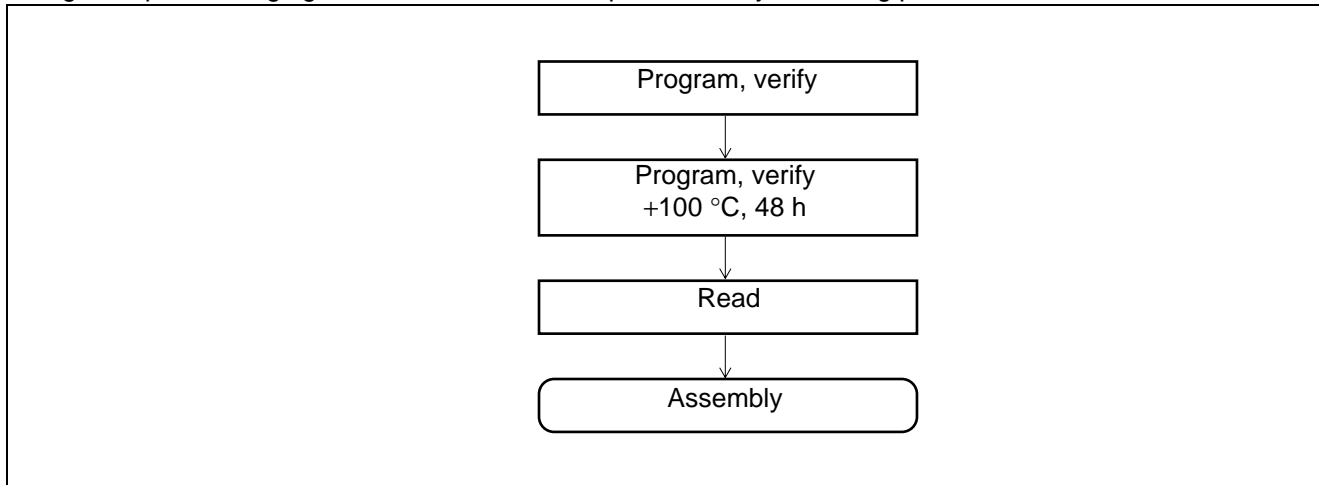

3.   Programming to the EPROM

In EPROM mode, the MB89P568 functions equivalent to the MBM27C1001. This allows the PROM to be programmed with a general-purpose EPROM programmer (the electronic signature mode cannot be used) by using the dedicated socket adapter.

• Programming procedure

(1) Set the EPROM programmer to the MBM27C1001.
(2) Load program data into the EPROM programmer at 4000_H to $FFFF_H$
(3) Program with the EPROM programmer.

4. Recommended Screening Conditions

High-temperature aging is recommended as the pre-assembly screening procedure.

```
        ┌─────────────────────┐
        │   Program, verify   │
        └─────────────────────┘
                  │
                  ▼
        ┌─────────────────────┐
        │   Program, verify   │
        │   +100 °C, 48 h     │
        └─────────────────────┘
                  │
                  ▼
        ┌─────────────────────┐
        │        Read         │
        └─────────────────────┘
                  │
                  ▼
        ╭─────────────────────╮
        │      Assembly       │
        ╰─────────────────────╯
```

5. Programming Yield

All bits cannot be programmed at FUJITSU MICROELECTRONICS shipping test to a blanked OTPROM micro-computer, due to its nature. For this reason, a programming yield of 100% cannot be assured at all times.

6. EPROM Programmer Socket Adapter

Package	Compatible socket adapter
FPT-80P-M05	ROM-80SQF-32DP-8LA
FPT-80P-M06	ROM-80QF-32DP-8LA2
FPT-80P-M11	ROM-80QF2-32DP-8LA2

Inquiry: San Hayato Co., Ltd.: FAX +81-3-5396-9106 (Tokyo)

MB89560A Series

■ PROGRAMMING TO THE EPROM WITH PIGGYBACK/EVALUATION DEVICE

1. EPROM for Use

MBM27C512-20TV

2. Programming Socket Adapter

To program to the PROM using an EPROM programmer, use the socket adapter (manufacturer: Sun Hayato Co., Ltd.) listed below.

Package	Adapter socket part number
LCC-32 (Rectangle)	ROM-32LC-28DP-YG

Inquiry: San Hayato Co., Ltd.: FAX +81-3-5396-9106 (Tokyo)

3. Memory Space
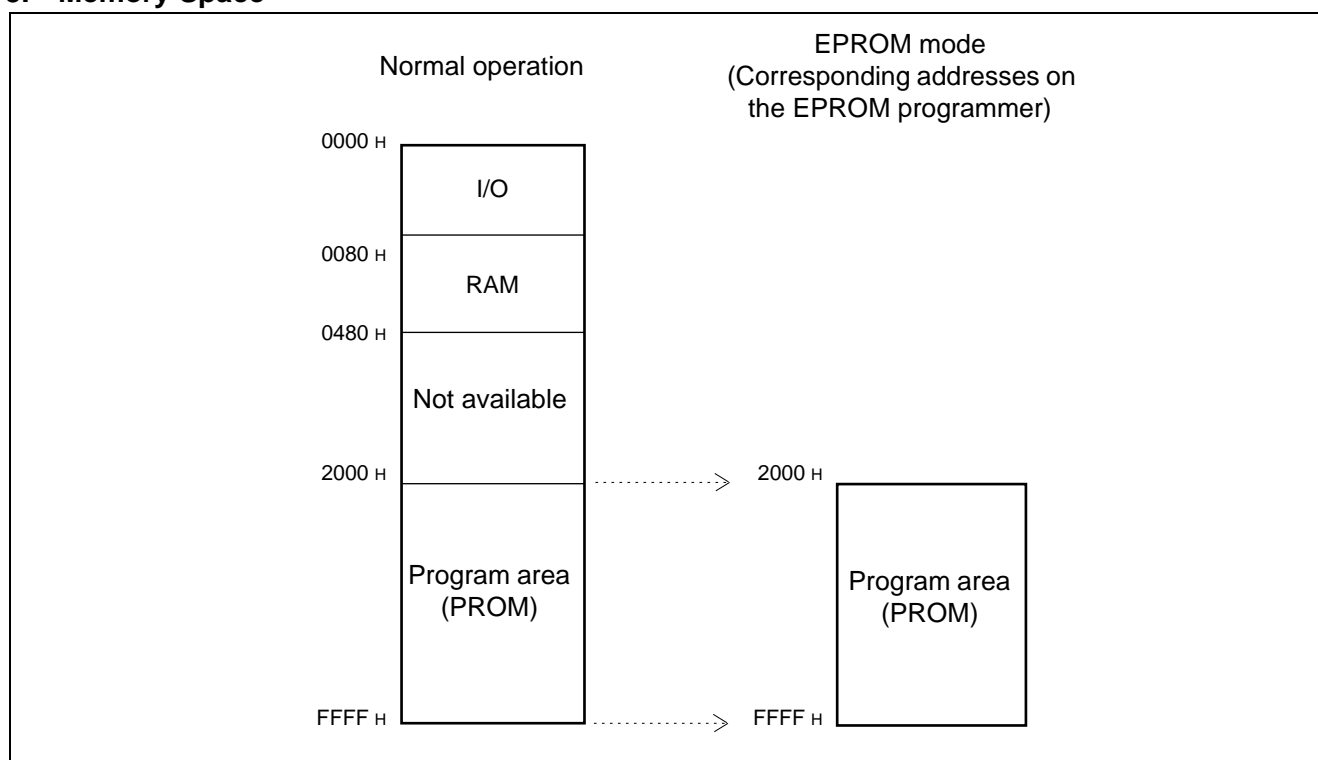
4. Programming to EPROM

(1) Set the EPROM programmer to the MBM27C512.

(2) Load program data into the EPROM programmer at 2000H to FFFFH.

(3) Program to 2000H to FFFFH with the EPROM programmer.

■ BLOCK DIAGRAM
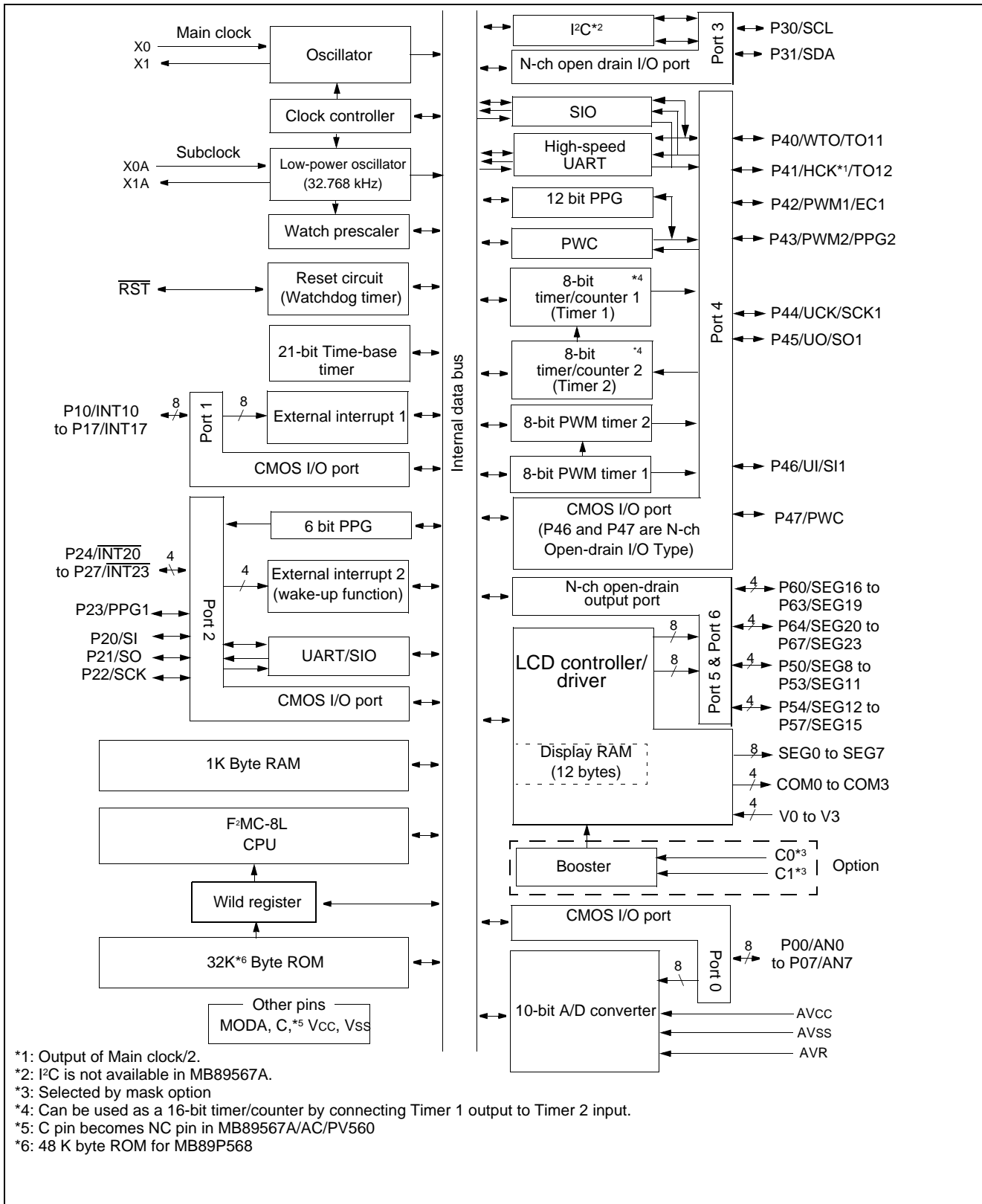
*1: Output of Main clock/2.
*2: I²C is not available in MB89567A.
*3: Selected by mask option
*4: Can be used as a 16-bit timer/counter by connecting Timer 1 output to Timer 2 input.
*5: C pin becomes NC pin in MB89567A/AC/PV560
*6: 48 K byte ROM for MB89P568

■ CPU CORE

1. Memory Space

The microcontrollers of the MB89560A series offer a memory space of 64 Kbytes for storing all of I/O, data, and program areas. The I/O area is located the lowest address. The data area is provided immediately above the I/O area. The data area can be divided into register, stack, and direct areas according to the application. The program area is located at exactly the opposite end, that is, near the highest address. Provide the tables of interrupt reset vectors and vector call instructions toward the highest address within the program area. The memory space of the MB89560A series is structured as illustrated below.

Memory space

MB89567A, MB89567AC

```
0000 H  |  I/O
0080 H  |
        |  RAM
0100 H  |  Register
0200 H  |
0480 H  |
        |  *2
0492 H  |
        |  Access
        |  prohibited
8000 H  |
        |  ROM
FFC0 H  |
FFFF H  |
```

Vector table
(Reset • Interrupt • Vector call instruction)

MB89P568-101,102

```
0000 H  |  I/O
0080 H  |
        |  RAM
0100 H  |  Register
0200 H  |
0480 H  |
        |  *2
0492 H  |
        |  Access
        |  prohibited
4000 H  |
        |  External*1
        |  ROM
FFC0 H  |
FFFF H  |
```

MB89PV560-101,102

```
0000 H  |  I/O
0080 H  |
        |  RAM
0100 H  |  Register
0200 H  |
0480 H  |
0492 H  |  *2
        |  Access
        |  prohibited
2000 H  |
        |  External*1
        |  ROM
FFC0 H  |
FFFF H  |
```

*1 : MB89P568-101,102 has OTP ROM inside.

*2 : Wild register setting registers

2. Registers

The F²MC-8L family has two types of registers; dedicated registers in the CPU and general-purpose registers in the memory. The following registers are provided:

Program counter (PC)   : A 16-bit register for indicating specifies instruction storage positions.
Accumulator (A)   : A 16-bit temporary register for storing arithmetic operations, etc. When the instruction is an 8-bit data processing instruction, the lower byte is used.
Temporary accumulator (T): A 16-bit register which performs arithmetic operations with the accumulator when the instruction is an 8-bit data processing instruction, the lower byte is used.
Index register (IX)   : A 16-bit register for index modification
Extra pointer (EP)   : A 16-bit pointer for indicating a memory address
Stack pointer (SP)   : A 16-bit register for indicating a stack area
Program status (PS)   : A 16-bit register for storing a register pointer, a condition code

```
         16 bits                                      Initial value

        [ P C ]      : Program counter          FFFDH
        [  A  ]      : Accumulator              Undefined
        [  T  ]      : Temporally accumulator   Undefined
        [ I X ]      : Indexing register        Undefined
        [ E P ]      : Extra pointer            Undefined
        [ S P ]      : Stuck pointer            Undefined
        [ P S ]      : Program status           I Flag = 0, IL1, 0 = 11
                                                other bits are undefined.
```

The PS can further be divided into higher 8 bits for use as a register bank pointer (RP) and the lower 8 bits for use as a condition code register (CCR). (See the diagram below.)

• Structure of program status

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
PS			RP			Va-cancy	Va-cancy	Va-cancy	H	I	IL1	IL0	N	Z	V	C

RP (bits 15-11), CCR (bits 7-0)
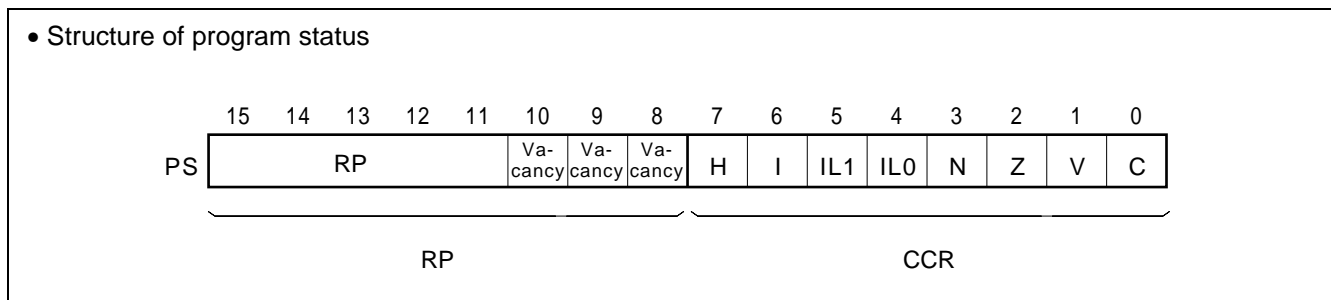
The RP indicates the address of the register bank currently in use. The relationship between the pointer contents and the actual address is based on the conversion rule illustrated below.

- Rule for Conversion of Actual Addresses of the General-purpose Register Area

								RP Upper					Operation Code lower		
"0"	"0"	"0"	"0"	"0"	"0"	"0"	"1"	R4	R3	R2	R1	R0	b2	b1	b0
↓	↓	↓	↓	↓	↓	↓	↓	↓	↓	↓	↓	↓	↓	↓	↓
A15	A14	A13	A12	A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1	A0

Generated address (left label for bottom row)
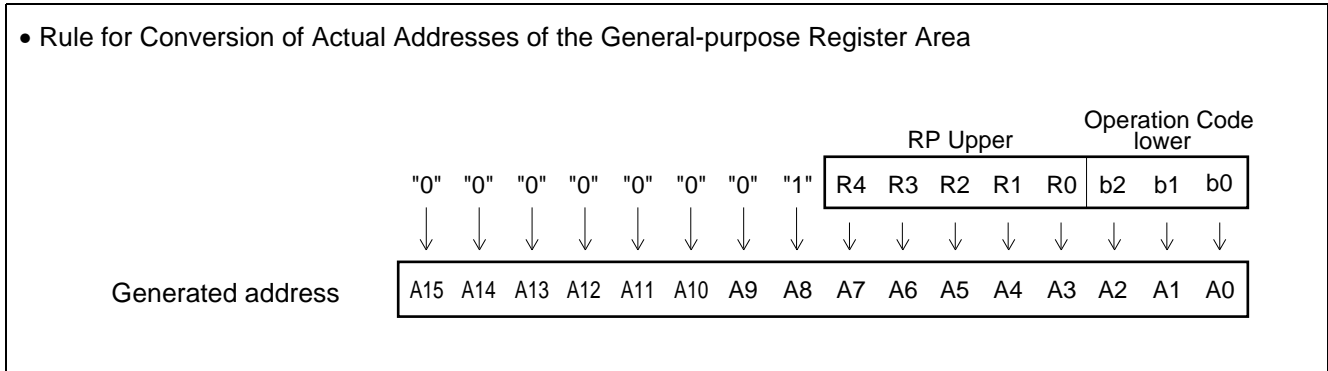
The CCR consists of bits indicating the results of arithmetic operations and the contents of transfer data and bits for control of CPU operations at the time of an interrupt.

H-flag : Set when a carry or a borrow from bit 3 to bit 4 occurs as a result of an arithmetic operation. Cleared otherwise. This flag is for decimal adjustment instructions.

I-flag : Interrupt is allowed when this flag is set to 1. Interrupt is prohibited when the flag is set to 0. Set to 0 when reset.

IL1, 0 : Indicates the level of the interrupt currently allowed. Processes an interrupt only if its request level is higher than the value indicated by this bit.

IL1	IL0	Interrupt level	High-low
0	0	1	High
0	1		
1	0	2	
1	1	3	Low = no interrupt

N-flag : Set if the MSB is set to 1 as the result of an arithmetic operation. Cleared when the bit is set to 0.

Z-flag : Set when an arithmetic operation results in 0. Cleared otherwise.

V-flag : Set if the complement on 2 overflows as a result of an arithmetic operation. Reset if the overflow does not occur.

C-flag : Set when a carry or a borrow from bit 7 occurs as a result of an arithmetic operation. Cleared otherwise. Set to the shift-out value in the case of a shift instruction.

The following general-purpose registers are provided :

General-purpose registers : An 8-bit resister for storing data

The general-purpose registers are 8 bits and located in the register banks of the memory. One bank contains eight registers. Up to a total of 32 banks can be used. The bank currently in use is indicated by the register bank pointer (RP).

• Register Bank Configuration
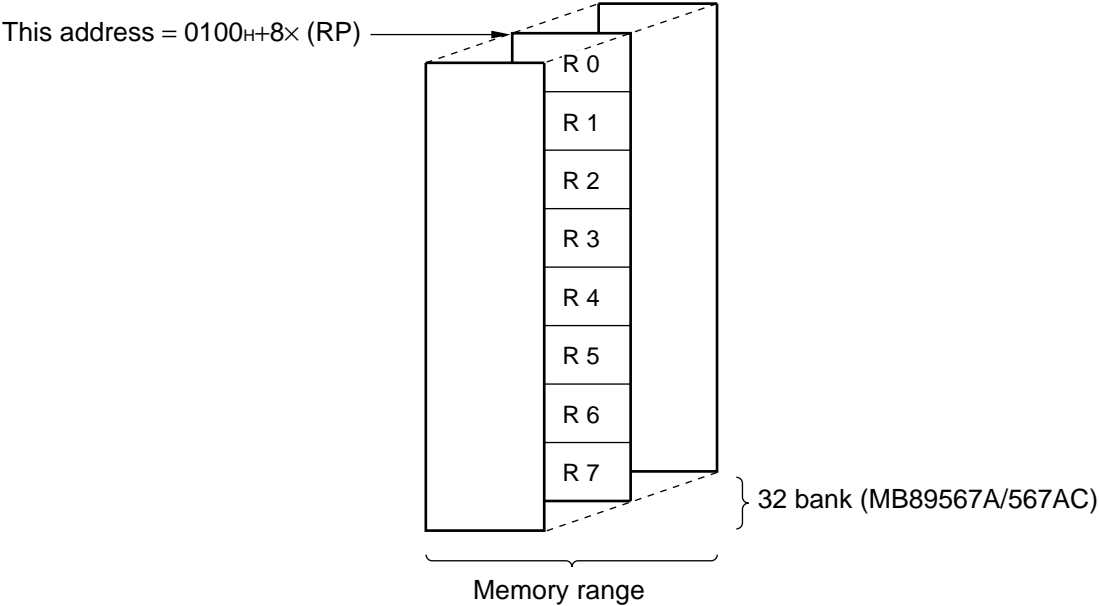
This address = $0100_H + 8 \times$ (RP)

R 0
R 1
R 2
R 3
R 4
R 5
R 6
R 7

32 bank (MB89567A/567AC)

Memory range

■ **I/O MAP**

Address	Register name	Register Description	Read/Write	Initial value
00H	PDR0	Port 0 data register	R/W	XXXXXXXXB
01H	DDR0	Port 0 data direction register	W	00000000B
02H	PDR1	Port 1 data register	R/W	XXXXXXXXB
03H	DDR1	Port 1 data direction register	W	00000000B
04H to 06H	(Vacancy)			
07H	SYCC	System clock control register	R/W	XXXMM100B
08H	STBC	Standby control register	R/W	00010XXXB
09H	WDTC	Watchdog timer control register	W	0XXXXXXXB
0AH	TBTC	Timebase timer control register	R/W	00XXX000B
0BH	WPCR	Watch prescaler control register	R/W	00XX0000B
0CH	PDR2	Port 2 data register	R/W	XXXXXXXXB
0DH	DDR2	Port 2 data direction register	R/W	00000000B
0EH	PDR3	Port 3 data register	R/W	XXXXXX11B
0FH	PDR4	Port 4 data register	R/W	XXXXXXXXB
10H	DDR4	Port 4 direction register	R/W	XX000000B
11H	PDR5	Port 5 data register	R/W	00000000B
12H	(Vacancy)			
13H	PDR6	Port 6 data register	R/W	00000000B
14H to 19H	(Vacancy)			
1AH	T2CR	Timer2 control register	R/W	X00000X0B
1BH	T2DR	Timer2 data register	R/W	XXXXXXXXB
1CH	T1CR	Timer1 control register	R/W	X00000X0B
1DH	T1DR	Timer1 data register	R/W	XXXXXXXXB
1EH to 21H	(Vacancy)			
22H	SMC11	UART1 mode control register 1	R/W	00000000B
23H	SRC1	UART1 mode data register	R/W	XX011000B
24H	SSD1	UART1 status/data register	R/W	00100X1XB
25H	SIDR1/SODR1	UART1 data register	R/W	XXXXXXXXB
26H	SMC12	UART1 mode control register 2	R/W	XX100001B
27H	CNTR1	PWM control register 1	R/W	00000000B
28H	CNTR2	PWM control register 2	R/W	000X0000B
29H	CNTR3	PWM control register 3	R/W	X000XXXXB
2AH	COMR1	PWM compare register 1	W	XXXXXXXXB
2BH	COMR2	PWM compare register 2	W	XXXXXXXXB
2CH	PCR1	PWC pulse width control register 1	R/W	000XX000B

(Continued)

Address	Register name	Register Description	Read/Write	Initial value
2D$_H$	PCR2	PWC pulse width control register 2	R/W	00000000$_B$
2E$_H$	RLBR	PWC reload buffer register	R/W	XXXXXXXX$_B$
2F$_H$	SMC21	UART2/SIO mode control register	R/W	00000000$_B$
30$_H$	SMC22	UART2/SIO mode control register 2	R/W	00000000$_B$
31$_H$	SSD2	UART2/SIO status/data register	R/W	00001XXX$_B$
32$_H$	SIDR2/SODR2	UART2/SIO data register	R/W	XXXXXXXX$_B$
33$_H$	SRC2	UART2/SIO rate control register	R/W	XXXXXXXX$_B$
34$_H$	ADC1	A/D control register 1	R/W	X00000X0$_B$
35$_H$	ADC2	A/D control register 2	R/W	X0000001$_B$
36$_H$	ADDL	A/D data register L	R/W	XXXXXXXX$_B$
37$_H$	ADDH	A/D data register H	R/W	XXXXXXXX$_B$
38$_H$	RCR21	PPG control register 1(PPG2)	R/W	00000000$_B$
39$_H$	RCR23	PPG control register 3(PPG2)	R/W	0X000000$_B$
3A$_H$	RCR22	PPG control register 2(PPG2)	R/W	XX000000$_B$
3B$_H$	RCR24	PPG control register 4(PPG2)	R/W	XX000000$_B$
3C$_H$ to 3E$_H$	(Vacancy)			
3F$_H$	EIC1	External interrupt 1 control register 1	R/W	00000000$_B$
40$_H$	EIC2	External interrupt 1 control register 2	R/W	00000000$_B$
41$_H$	EIC3	External interrupt 1 control register 3	R/W	00000000$_B$
42$_H$	EIC4	External interrupt 1 control register 4	R/W	00000000$_B$
43$_H$ to 50$_H$	(Vacancy)			
51$_H$	IBSR	I^{2}C bus status register	R	00000000$_B$
52$_H$	IBCR	I^{2}C bus control register	R/W	00000000$_B$
53$_H$	ICCR	I^{2}C clock control register	R/W	000XXXXX$_B$
54$_H$	IADR	I^{2}C address register	R/W	XXXXXXXX$_B$
55$_H$	IDAR	I^{2}C data register	R/W	XXXXXXXX$_B$
56$_H$	EIE2	External interrupt 2 enable register	R/W	XXXX0000$_B$
57$_H$	EIF2	External interrupt 2 flag register	R/W	XXXXXXX0$_B$
58$_H$	RCR1	PPG control register 1(PPG1)	R/W	00000000$_B$
59$_H$	RCR2	PPG control register 2(PPG1)	R/W	0X000000$_B$
5A$_H$	CKR	Clock Output control register	R/W	00000000$_B$
5B$_H$	LCR1	LCD controller/driver control register 1	R/W	00010000$_B$
5C$_H$	LCR2	LCD controller/driver control register 2	R/W	00000000$_B$
5D$_H$	LCR3	LCD controller/driver control register 3	R/W	XX000000$_B$
5E$_H$	LDR1	LCD data register 1	R/W	XXXXXXXX$_B$

(Continued)

MB89560A Series

(Continued)

Address	Register name	Register Description	Read/Write	Initial value
5F$_H$	(Vacancy)			
60$_H$ to 6B$_H$	VRAM	Display RAM	R/W	XXXXXXXX$_B$
6C$_H$ to 6F$_H$	(Vacancy)			
70$_H$	SMR	Serial I/O mode register	R/W	00000000$_B$
71$_H$	SDR	Serial I/O data register	R/W	XXXXXXXX$_B$
72$_H$	PURR0	Pull-up resistor register 0	R/W	11111111$_B$
73$_H$	PURR1	Pull-up resistor register 1	R/W	11111111$_B$
74$_H$	PURR2	Pull-up resistor register 2	R/W	11111111$_B$
75$_H$	PURR4	Pull-up resistor register 4	R/W	XX111111$_B$
76$_H$	(Vacancy)			
77$_H$	WREN	Wild register enable register	R/W	XX000000$_B$
78$_H$	WROR	Wild register data test register	R/W	XX000000$_B$
79$_H$	ADEN	A/D port input enable register	R/W	11111111$_B$
7A$_H$	(Vacancy)			
7B$_H$	ILR1	Interrupt level setting register 1	W	11111111$_B$
7C$_H$	ILR2	Interrupt level setting register 2	W	11111111$_B$
7D$_H$	ILR3	Interrupt level setting register 3	W	11111111$_B$
7E$_H$	ILR4	Interrupt level setting register 4	W	11111111$_B$
7F$_H$	ITR	Interrupt test register	Access Prohibited	11111111$_B$

Read/write access symbols
R/W : Readable and writable
R : Read-only
W : Write-only

Initial value symbols
0 : The initial value of this bit is "0".
1 : The initial value of this bit is "1".
X : The initial value of this bit is undefined.
M : The initial value of this bit is determined by mask option.

Note : Do not use vacancies.

■ WILD REGISTER I/O MAP

Address	Register name	Register description	Read/Write	Initial value
480$_H$	WRARH1	Wild register high-byte address register1	R/W	XXXXXXXX$_B$
481$_H$	WRARL1	Wild register low-byte address register1	R/W	XXXXXXXX$_B$
482$_H$	WRDR1	Wild register data register1	R/W	XXXXXXXX$_B$
483$_H$	WRARH2	Wild register high-byte address register2	R/W	XXXXXXXX$_B$
484$_H$	WRARL2	Wild register low-byte address register2	R/W	XXXXXXXX$_B$
485$_H$	WRDR2	Wild register data register2	R/W	XXXXXXXX$_B$
486$_H$	WRARH3	Wild register high-byte address register3	R/W	XXXXXXXX$_B$
487$_H$	WRARL3	Wild register low-byte address register3	R/W	XXXXXXXX$_B$
488$_H$	WRDR3	Wild register data register3	R/W	XXXXXXXX$_B$
489$_H$	WRARH4	Wild register high-byte address register4	R/W	XXXXXXXX$_B$
48A$_H$	WRARL4	Wild register low-byte address register4	R/W	XXXXXXXX$_B$
48B$_H$	WRDR4	Wild register data register4	R/W	XXXXXXXX$_B$
48C$_H$	WRARH5	Wild register high-byte address register5	R/W	XXXXXXXX$_B$
48D$_H$	WRARL5	Wild register low-byte address register5	R/W	XXXXXXXX$_B$
48E$_H$	WRDR5	Wild register data register5	R/W	XXXXXXXX$_B$
48F$_H$	WRARH6	Wild register high-byte address register6	R/W	XXXXXXXX$_B$
490$_H$	WRARL6	Wild register low-byte address register6	R/W	XXXXXXXX$_B$
491$_H$	WRDR6	Wild register data register6	R/W	XXXXXXXX$_B$

Read/write access symbols
R/W : Readable and writable
R   : Read-only
W   : Write-only

Initial value symbols
0   : The initial value of this bit is "0".
1   : The initial value of this bit is "1".
X   : The initial value of this bit is undefined.
M   : The initial value of this bit is determined by mask option.

Note : Do not use vacancies.

■ ELECTRICAL CHARACTERISTICS

1. Absolute Maximum Ratings

$(AV_{SS} = V_{SS} = 0.0\ V)$

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power supply voltage	V_{CC} AV_{CC}	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	MB89567A, MB89567AC, MB89P568 and MB89PV560*1 AVR must not exceed "AVcc + 0.3V".
	AVR	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	
LCD power voltage	V0 to V3	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	V0 to V3 should not exceed Vcc Without booster
Program voltage	V_{PP}	$V_{SS} - 0.6$	$V_{SS} + 13.0$	V	Only for the MB89P568
Input voltage	V_I	$V_{SS} - 0.3$	$V_{CC} + 0.3$	V	For pins other than P30, P31, P46, P47, P50 to P57 and P60 to P67
		$V_{SS} - 0.3$	$V_{CC} + 0.3$	V	P50 to P57, P60 to P67 Resister Ladder option
		$V_{SS} - 0.3$	V3	V	P50 to P57, P60 to P67 LCD booster option
		$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	For P30, P31, P46, P47
Output voltage	V_O	$V_{SS} - 0.3$	$V_{CC} + 0.3$	V	For pins other than P30, P31, P46, P47, P50 to P57 and P60 to P67
		$V_{SS} - 0.3$	$V_{CC} + 0.3$	V	P50 to P57, P60 to P67 Resister Ladder option
		$V_{SS} - 0.3$	V3	V	P50 to P57, P60 to P67 LCD booster option
		$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	For P30, P31, P46, P47
"L" level maximum output current	I_{OL}	—	15	mA	For pins other than P20 to P27
			30	mA	For P20 to P27 only
"L" level average output current	I_{OLAV}	—	4	mA	For pins other than P20 to P27*2
			15	mA	For P20 to P27 only*2
"L" level total maximum output current	ΣI_{OL}	—	100	mA	
"L" level total average output current	ΣI_{OLAV}	—	60	mA	*2
"H" level maximum output current	I_{OH}	—	– 15	mA	For pins other than P20 to P27, P30, P31, P46, P47, P50 to P57, P60 to P67
			– 30	mA	For P20 to P27 only
"H" level average output current	I_{OHAV}	—	– 4	mA	For pins other than P20 to P27*2
			– 15	mA	For P20 to P27 only*2

(Continued)

(Continued)

$(AV_{SS} = V_{SS} = 0.0\ V)$

Parameter	Symbol	Rating Min	Rating Max	Unit	Remarks
"H" level total maximum output current	ΣI_{OH}	—	– 50	mA	
"H" level total average output current	ΣI_{OHAV}	—	– 30	mA	*2
Power consumption	P_D	—	300	mW	
Operating temperature	T_A	– 40	+ 85	°C	
Storage temperature	Tstg	– 55	+ 150	°C	

*1 : Use AV_{CC} and V_{CC} set at the same voltage.
　　　Take care so that AVR does not exceed AV_{CC} + 0.3 V, such as when power is turned on.
　　　Take care so that AV_{CC} does not exceed V_{CC}, such as when power is turned on.

*2 : Average value (operating current × operating rate)

WARNING:　Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

MB89560A Series

2. Recommended Operating Conditions

$(AV_{SS} = V_{SS} = 0.0 \text{ V})$

Parameter	Symbol	Value		Unit	Remarks
		Min	Max		
Power supply voltage	V_{CC} AV_{CC}	2.2*	5.5*	V	For MB89567A and MB89567AC
		1.5	5.5	V	Retains the RAM state in stop mode for MB89567A and MB89567AC
		2.7*	5.5*	V	For MB89PV560 and MB89P568
		1.5	5.5	V	Retains the RAM state in stop mode for MB89PV560 and MB89P568
LCD power voltage	V0 to V3	V_{ss}	V_{CC}	V	Liquid crystal power supply range : without booster (The best value is according to the specification of LCD used.)
A/D converter reference input voltage	AVR	3.5	AV_{CC}	V	
Operating temperature	T_A	– 40	+ 85	°C	

* : These values depend on the operating conditions and the analog assurance range. See Figure "Operating Voltage vs. Main Clock Operating Frequency (MB89567A, MB89567AC) ", "Operating Voltage vs. Main Clock Operating Frequency (MB89P568/MB89PV560) " and "6. A/D Converter Electrical Characteristics."

"Operating Voltage vs. Main Clock Operating Frequency (MB89567A, MB89567AC) and "Operating Voltage vs. Main Clock Operating Frequency (MB89P568/MB89PV560) indicate the operating frequency of the external oscillator at an instruction cycle of 4/F$_{CH}$

Operating Voltage vs. Main Clock Operating Frequency (MB89567A, MB89567AC)

Operation assurance : $T_A = -10\ °C$ to $+55\ °C$ (Only for MB89P568)

Operating Voltage vs. Main Clock Operating Frequency (MB89P568/MB89PV560)
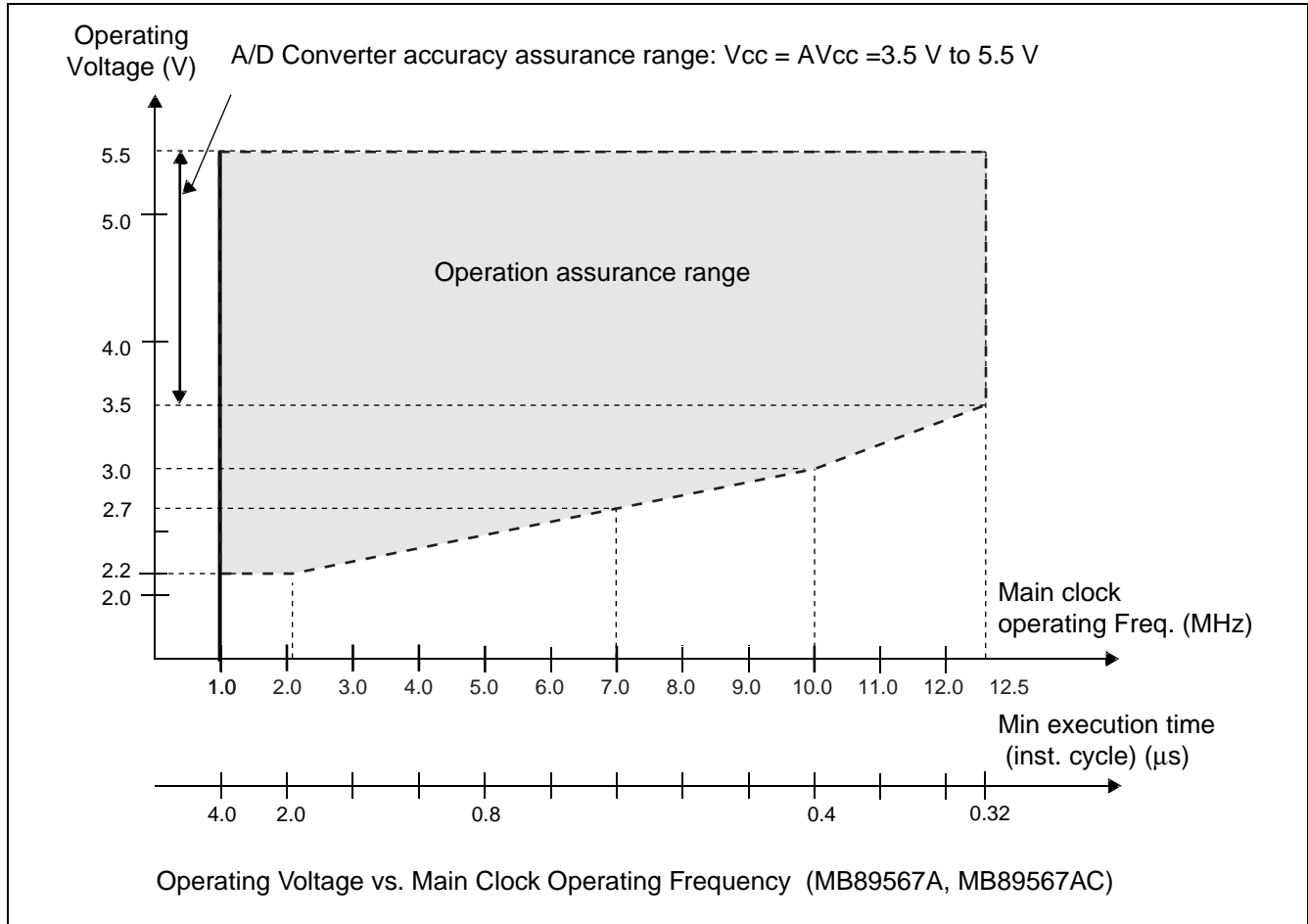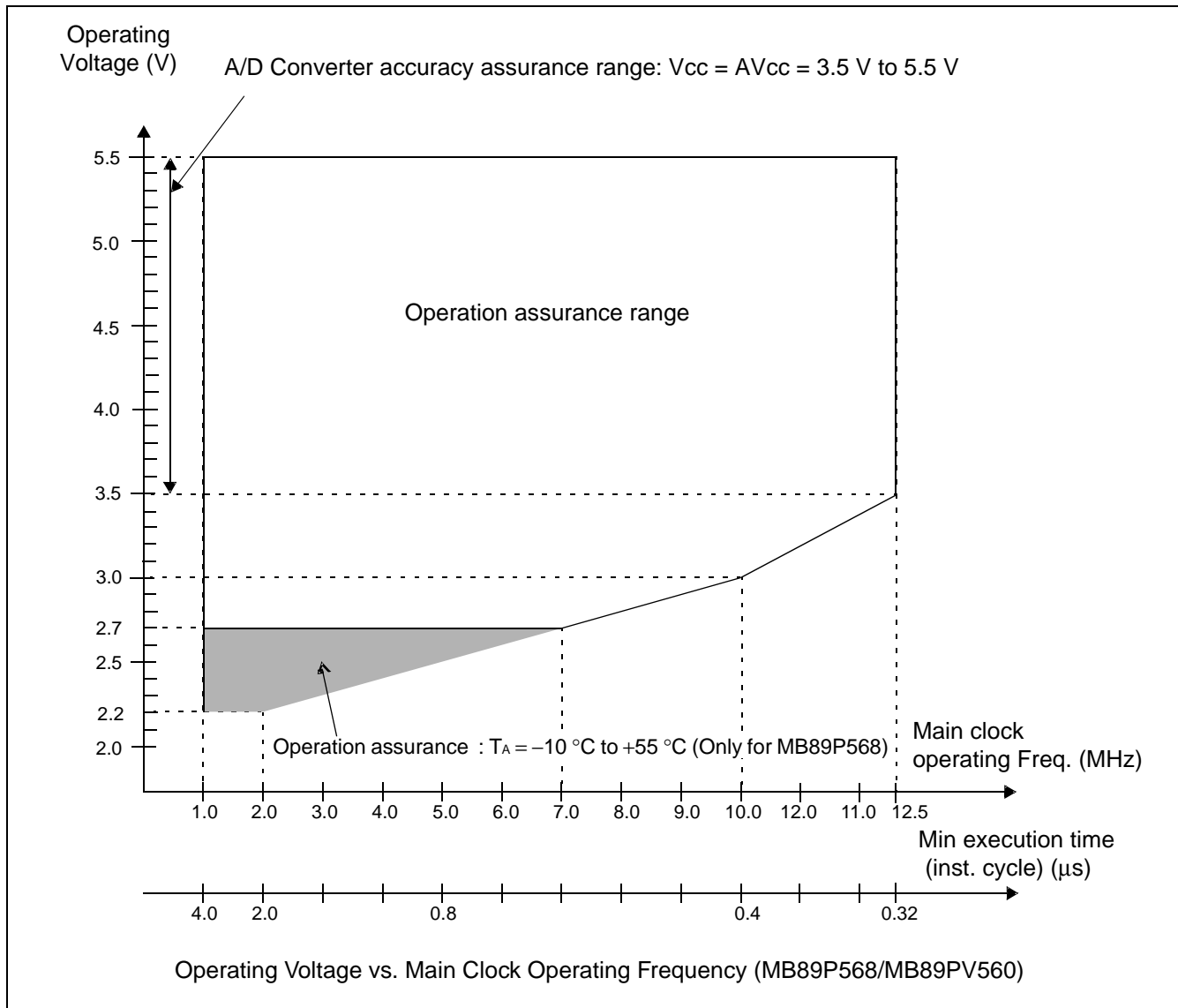
Since the operating voltage range is dependent on the instruction cycle, see minimum execution time if the operating speed is switched using a gear.

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

3. DC Characteristics (power supply voltage : 5.0V)

$(AV_{CC} = V_{CC} = 5.0\ V,\ AV_{SS} = V_{SS} = 0.0\ V,\ T_A = -40\ °C\ to\ +85\ °C)$

Parameter	Symbol	Pin	Condition	Value Min	Typ	Max	Unit	Remarks
"H" level input voltage	V_{IH}	P00 to P07, P10 to P17, P20 to P27, P30 to P31, P40 to P45, P50 to P57, P60 to P67	—	$0.7\ V_{CC}$	—	$V_{CC} + 0.3$	V	CMOS
	V_{IHS}	$\overline{RST}$, MODA, INT10 to INT17, INT20 to INT23, SI,SCK,EC1,UCK, SCK1,UI,SI1,PWC	—	$0.8\ V_{CC}$	—	$V_{CC} + 0.3$	V	Hysteresis
	V_{IHSMB}	SCL, SDA	—	$V_{SS} + 1.4$	—	$V_{SS} + 5.5$	V	SMB input buffer selected
	V_{IHI2C}		—	$0.7\ V_{CC}$	—	$V_{SS} + 5.5$	V	I²C input buffer selected
"L" level input voltage	V_{IL}	P00 to P07, P10 to P17, P20 to P27, P30 to P31, P40 to P45, P50 to P57, P60 to P67	—	$V_{SS} - 0.3$	—	$0.3\ V_{CC}$	V	CMOS
	V_{ILS}	$\overline{RST}$, MODA, INT10 to INT17, INT20 to INT23, SI,SCK,EC1,UCK, SCK1,UI,SI1,PWC	—	$V_{SS} - 0.3$	—	$0.2\ V_{CC}$	V	Hysteresis
	V_{ILSMB}	SCL, SDA	—	$V_{SS} - 0.3$	—	$V_{SS} + 0.6$	V	SMB input buffer selected
	V_{ILI2C}		—	$V_{SS} - 0.3$	—	$0.3\ V_{CC}$	V	I²C input buffer selected
Open-drain output pin application voltage	V_D	P60 to P67, P50 to P57	—	$V_{SS} - 0.3$	—	$V_{CC} + 0.3$	V	Resister Ladder option
		P60 to P67, P50 to P57	—	$V_{SS} - 0.3$	—	V3	V	LCD booster option
		P46, P47, P30, P31	—	$V_{SS} - 0.3$	—	$V_{SS} + 5.5$	V	
"H" level output voltage	V_{OH}	P00 to P07, P10 to P17, P40 to P45	$I_{OH} = -2.0\ mA$	4.0	—	—	V	
		P20 to P27	$I_{OH} = -15.0\ mA$	4.0	—	—		

(Continued)

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$(AV_{CC} = V_{CC} = 5.0 \text{ V}, AV_{SS} = V_{SS} = 0.0 \text{ V}, T_A = -40\,°\text{C to } +85\,°\text{C})$

Parameter	Symbol	Pin	Condition	Min	Typ	Max	Unit	Remarks
"L" level output voltage	V_{OL}	P00 to P07, P10 to P17, P30, P31, P40 to P47, P50 to P57, P60 to P67, $\overline{RST}$	I_{OL} = 4.0 mA	—	—	0.4	V	
		P20 to P27	I_{OL} = 15.0 mA	—	—	0.4		
Input leakage current (High-Z output leakage current)	I_{LI}	P00 to P07, P10 to P17, P20 to P27, P40 to P45	$0.0 \text{ V} < V_I < V_{CC}$	− 5	—	+5	µA	Without pull-up Resistor
		P50 to P57, P60 to P67		− 5	—	+5	µA	Resistor Ladder option
		P50 to P57, P60 to P67	$0.0 \text{ V} < V_I < V3$	− 5	—	+5	µA	LCD booster option
		MODA	$0.0 \text{ V} < V_I < V_{CC}$	− 10	—	+10	µA	MB89PV560 MB89P568
Open-drain output leakage current	I_{LIOD}	P50 to P57, P60 to P67	$0.0 \text{ V} < V_I < V_{CC}$	—	—	+5	µA	Resistor Ladder option
		P50 to P57, P60 to P67	$0.0 \text{ V} < V_I < V3$	—	—	+5	µA	LCD booster option
		P30, P31, P46, P47	$0.0 \text{ V} < V_I < V_{SS} + 5.5 \text{ V}$	—	—	+5	µA	
Pull-up resistance	R_{PULL}	P00 to P07, P10 to P17, P20 to P27, P40 to P45, $\overline{RST}$	V_I = 0.0 V	25	50	100	kΩ	When pull-up resistor selected except $\overline{RST}$
Pull-down resistance	R_{MODA}	MODA	V_I = 3.0 V	50	100	200	kΩ	MB89567A/ MB89567AC
Power supply current *1	I_{CC1}	V_{CC}	F_{CH} = 10 MHz, t_{inst}*2 = 0.4 µs, Main clock run mode	—	15	20	mA	MB89PV560 MB89P568
				—	8	13	mA	MB89567A MB89567AC
	I_{CC2}		F_{CH} = 10 MHz, t_{inst}*2 = 6.4 µs, Main clock run mode	—	5	8.5	mA	MB89PV560 MB89P568
				—	1	3	mA	MB89567A MB89567AC
	I_{CCS1}		F_{CH} = 10 MHz, t_{inst}*2 = 0.4 µs, Main clock sleep mode	—	5	7	mA	MB89PV560 MB89P568
				—	2.5	5	mA	MB89567A MB89567AC

(Continued)

(Continued)

$(AV_{CC} = V_{CC} = 5.0 \text{ V}, , AV_{SS} = V_{SS} = 0.0 \text{ V}, T_A = -40 \text{ °C to } +85 \text{ °C})$

Parameter	Symbol	Pin	Condition	Value Min	Value Typ	Value Max	Unit	Remarks
Power supply current *1	I_{CCS2}	V_{CC}	$F_{CH} = 10$ MHz, t_{inst}*2 = 6.4 µs, Sleep mode	—	1.5	3	mA	MB89PV560 MB89P568
				—	0.7	2	mA	MB89567A MB89567AC
	I_{CCL}		$F_{CL} = 32.768$ kHz, Subclock mode, $T_A = +25$ °C	—	3	7	mA	MB89PV560 MB89P568
				—	50	85	µA	MB89567A MB89567AC
	I_{CCLS}		$F_{CL} = 32.768$ kHz, Subclock sleep mode, $T_A = +25$ °C	—	30	50	µA	MB89PV560 MB89P568
				—	15	30	µA	MB89567A MB89567AC
	I_{CCT}		$F_{CL} = 32.768$ kHz, $T_A = +25$ °C, Watch mode, Main clock stop mode	—	5	15	µA	MB89PV560 MB89P568
				—	1.6	15	µA	MB89567A MB89567AC
Power supply current *1	I_{CCH}	V_{CC}	$T_A = +25$ °C, Subclock stop mode	—	3	10	µA	MB89PV560 MB89P568
				—	1	10	µA	MB89567A MB89567AC
LCD divided resistance	R_{LCD}	—	Between V_{CC} and V_{SS}	300	500	750	kΩ	
COM0 to COM3 output impedance	R_{VCOM}	COM0 to COM3	V1 to V3 = 5.0 V	—	—	5	kΩ	
SEG0 to SEG23 output impedance	R_{VSEG}	SEG0 to SEG23		—	—	15	kΩ	
LCD controller/ driver leakage current	I_{LCDL}	V0 to V3, COM0 to COM3, SEG0 to SEG23	—	–1	—	1	µA	
Input capacitance	C_{IN}	Other than AV_{CC}, AV_{SS}, V_{CC}, and V_{SS}	f = 1 MHz	—	10	—	pF	

*1 : The power supply current is measured at the external clock

*2 : For information on t_{inst}, see "5. AC Characteristics (4) Instruction Cycle."

Note : For LCD and port multiplex pin (P50 to P57, P60 to P67), please refer to LCD specification when the port is used, and refer to LCD specification when used as LCD pin.

4. DC Characteristics (power supply voltage : 3.0V)

$(AV_{CC} = V_{CC} = 3.0V, AV_{SS} = V_{SS} = 0.0 V, T_A = -40 \,°C \text{ to } +85 \,°C)$

Parameter	Symbol	Pin	Condition	Value			Unit	Remarks
				Min	Typ	Max		
"H" level input voltage	V_{IH}	P00 to P07, P10 to P17, P20 to P27, P30 to P31, P40 to P45, P50 to P57, P60 to P67	—	$0.7 V_{CC}$	—	$V_{CC} + 0.3$	V	CMOS
	V_{IHS}	$\overline{RST}$, MODA, $\overline{INT10}$ to $\overline{INT17}$, $\overline{INT20}$ to $\overline{INT23}$, SI,SCK,EC1,UCK, SCK1,UI,SI1,PWC	—	$0.8 V_{CC}$	—	$V_{CC} + 0.3$	V	Hysteresis
	V_{IHSMB}	SCL, SDA	—	$V_{SS} +1.4$	—	$V_{SS} + 5.5$	V	SMB input buffer selected
	V_{IHI2C}		—	$0.7 V_{CC}$	—	$V_{SS} + 5.5$	V	I²C input buffer selected
"L" level input voltage	V_{IL}	P00 to P07, P10 to P17, P20 to P27, P30 to P31, P40 to P45, P50 to P57, P60 to P67	—	$V_{SS} - 0.3$	—	$0.3 V_{CC}$	V	CMOS
	V_{ILS}	$\overline{RST}$, MODA, INT10 to INT17, INT20 to INT23, SI,SCK,EC1,UCK, SCK1,UI,SI1,PWC	—	$V_{SS} - 0.3$	—	$0.2 V_{CC}$	V	Hysteresis
	V_{ILSMB}	SCL, SDA	—	$V_{SS} - 0.3$	—	$V_{SS} + 0.6$	V	SMB input buffer selected
	V_{ILI2C}		—	$V_{SS} - 0.3$	—	$0.3 V_{CC}$	V	I²C input buffer selected
Open-drain output pin application voltage	V_D	P60 to P67, P50 to P57	—	$V_{SS} - 0.3$	—	$V_{CC} + 0.3$	V	Resistor Ladder option
		P60 to P67, P50 to P57	—	$V_{SS} - 0.3$	—	V3	V	LCD booster option
		P46, P47, P30, P31	—	$V_{SS} - 0.3$	—	$V_{SS} + 5.5$	V	
"H" level output voltage	V_{OH}	P00 to P07, P10 to P17, P40 to P45	$I_{OH} = -2.0 \text{ mA}$	2.4	—	—	V	
		P20 to P27	$I_{OH} = -10 \text{ mA}$	2.4	—	—		

(Continued)

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(AV$_{CC}$ = V$_{CC}$ = 3.0V, AV$_{SS}$ = V$_{SS}$ = 0.0 V, T$_A$ = −40 °C to +85 °C)

Parameter	Symbol	Pin	Condition	Value			Unit	Remarks
				Min	Typ	Max		
"L" level output voltage	V$_{OL}$	P00 to P07, P10 to P17, P30, P31, P40 to P47, P50 to P57, P60 to P67, $\overline{RST}$	I$_{OL}$ = 4.0 mA	—	—	0.4	V	
		P20 to P27	I$_{OL}$ = 10 mA	—	—	0.4		
Input leakage current (Hi-z output leakage current)	I$_{LI}$	P00 to P07, P10 to P17, P20 to P27, P40 to P45	0.0 V < V$_I$ < V$_{CC}$	−5	—	+5	μA	Without pull-up Resister
		P50 to P57, P60 to P67		−5	—	+5	μA	Resister Ladder option
		P50 to P57, P60 to P67	0.0 V < V$_I$ < V3	−5	—	+5	μA	LCD booster option
		MODA	0.0 V < V$_I$ < V$_{CC}$	−10	—	+10	μA	MB89PV560 MB89P568
Open-drain output leakage current	I$_{LIOD}$	P50 to P57, P60 to P67	0.0 V < V$_I$ < V$_{CC}$	—	—	+5	μA	Resister Ladder option
		P50 to P57, P60 to P67	0.0 V < V$_I$ < V3	—	—	+5	μA	LCD booster option
		P30, P31, P46, P47	0.0 V < V$_I$ < V$_{ss}$ + 5.5 V	—	—	+5	μA	
Pull-up resistance	R$_{PULL}$	P00 to P07, P10 to P17, P20 to P27, P40 to P45, $\overline{RST}$	V$_I$ = 0.0 V	50	100	200	kΩ	When pull-up resistor selected except $\overline{RST}$
Pull-down resistance	R$_{MODA}$	MODA	V$_I$ = 5.0 V	25	50	100	kΩ	MB89567A MB89567AC
Power supply current *1	I$_{CC1}$	V$_{CC}$	F$_{CH}$ = 10 MHz, t$_{inst}$*2 = 0.4 μs, Main clock run mode	—	6	10	mA	MB89PV560 MB89P568
				—	4	9		MB89567A MB89567AC
	I$_{CC2}$		F$_{CH}$ = 10 MHz, t$_{inst}$*2 = 6.4 μs, Main clock run mode	—	1.5	3	mA	MB89PV560 MB89P568
				—	0.4	2		MB89567A MB89567AC

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$(AV_{CC} = V_{CC} = 3.0 \text{ V}, AV_{SS} = V_{SS} = 0.0 \text{ V}, T_A = -40 °C \text{ to } +85 °C)$

Parameter	Symbol	Pin	Condition	Value Min	Value Typ	Value Max	Unit	Remarks
Power supply current *1	I_{CCS1}	V_{CC}	$F_{CH} = 10$ MHz, t_{inst}*2 $= 0.4$ μs, Main clock sleep mode	—	2	4	mA	MB89PV560 MB89P568
				—	1	3	mA	MB89567A MB89567AC
	I_{CCS2}		$F_{CH} = 10$ MHz, t_{inst}*2 $= 6.4$ μs, Main clock sleep mode	—	1	2	mA	MB89PV560 MB89P568
				—	0.3	1.5	mA	MB89567A MB89567AC
	I_{CCL}		$F_{CL} = 32.768$ kHz, Subclock mode, $T_A = +25$ °C	—	1	3	mA	MB89PV560 MB89P568
				—	25	60	μA	MB89567A MB89567AC
	I_{CCLS}		$F_{CL} = 32.768$ kHz, Subclock sleep mode , $T_A = +25$ °C	—	15	30	μA	MB89PV560 MB89P568
				—	8	25	μA	MB89567A MB89567AC
	I_{CCT}		$F_{CL} = 32.768$ kHz, $T_A = +25$ °C, Watch mode, Main clock stop mode	—	5	15	μA	MB89PV560 MB89P568
				—	1	14	μA	MB89567A MB89567AC
	I_{CCH}		$T_A = +25$ °C, Subclock stop mode	—	1	5	μA	
LCD divided resistance	R_{LCD}	—	Between V_{CC} and V_{SS}	300	500	750	kΩ	
COM0 to COM3 output impedance	R_{VCOM}	COM0 to COM3	V1 to V3 = 3.0 V	—	—	5	kΩ	
SEG0 to 23 output impedance	R_{VSEG}	SEG0 to SEG23		—	—	15	kΩ	
LCD controller/ driver leakage current	I_{LCDL}	V0 to V3, COM0 to COM3, SEG0 to SEG23	—	—	−1	—	1	μA
Input capacitance	C_{IN}	Other than AV_{CC}, AV_{SS}, V_{CC}, and V_{SS}	$f = 1$ MHz	—	10	—	pF	

*1 : The power supply current is measured at the external clock

*2 : For information on t_{inst}, see "5. AC Characteristics (4) Instruction Cycle."

Note : For LCD and port multiplex pin (P50 to P57, P60 to P67), please refer to LCD specification when the port is used, and refer to LCD specification when used as LCD pin.

5.   AC Characteristics

(1) Reset Timing

$(V_{CC} = 5.0 \text{ V}, AV_{SS} = V_{SS} = 0.0 \text{ V}, T_A = -40 \text{ °C to } +85 \text{ °C})$

Parameter	Symbol	Condition	Value		Unit	Remarks
			Min	Max		
$\overline{RST}$ "L" pulse width	t_{ZLZH}	—	48 t_{HCYL}	—	ns	

Notes : • t_{HCYL} is the oscillation cycle ($1/F_{CH}$) to input to the X0 pin.
   • If the reset pulse applied to the external reset pin ($\overline{RST}$) does not meet the specifications, it may cause malfunctions. Use caution so that the reset pulse less than the specifications will not be fed to the external reset pin ($\overline{RST}$) .
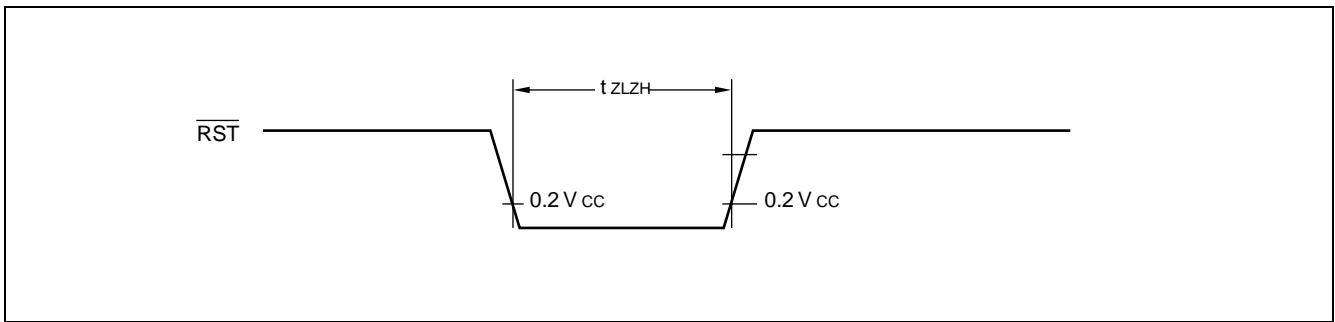
(2) Power-on Reset

$(AV_{SS} = V_{SS} = 0.0 \text{ V}, T_A = -40 \text{ °C to } +85 \text{ °C})$

Parameter	Symbol	Condition	Value		Unit	Remarks
			Min	Max		
Power supply rising time	t_R	—	0.5	50	ms	
Power supply cut-off time	t_{OFF}		1	—	ms	Due to repeated operations

Note : Make sure that power supply rises within the selected oscillation stabilization time.
   For example, when the main clock is operating at 10 MHz (F_{CH}) and the oscillation stabilization time select option has been set to $2^{18}/F_{CH}$, the oscillation stabilization delay time is 26.2 ms. Therefore, the maximum value of power supply rising time is about 26.2 ms.
   Rapid changes in power supply voltage may cause a power-on reset. If power supply voltage needs to be varied in the course of operation, a smooth voltage rise is recommended.
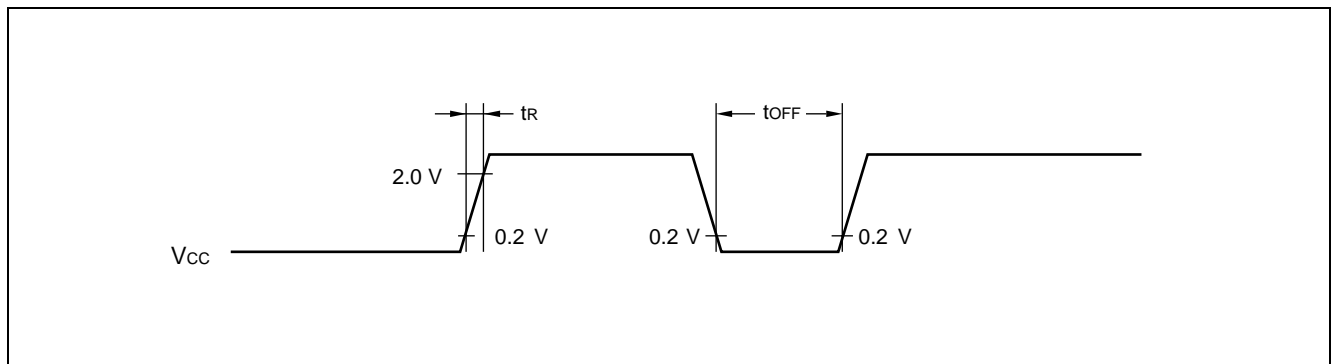
(3) Clock Timing

$(AV_{SS} = V_{SS} = 0.0 \text{ V}, T_A = -40 \text{ °C to } +85 \text{ °C})$

Parameter	Symbol	Pin	Value			Unit	Remarks
			Min	Typ	Max		
Clock frequency	F_{CH}	X0, X1	1	—	12.5	MHz	Main clock
	F_{CL}	X0A, X1A	—	32.768	—	kHz	Subclock
Clock cycle time	t_{HCYL}	X0, X1	80	—	1000	ns	Main clock
	t_{LCYL}	X0A, X1A	—	30.5	—	μs	Subclock
Input clock pulse width	P_{WH} P_{WL}	X0	20	—	—	ns	External clock
Input clock rising/falling time	t_{CR} t_{CF}	X0	—	—	10	ns	External clock

X0 and X1 Timing and Conditions
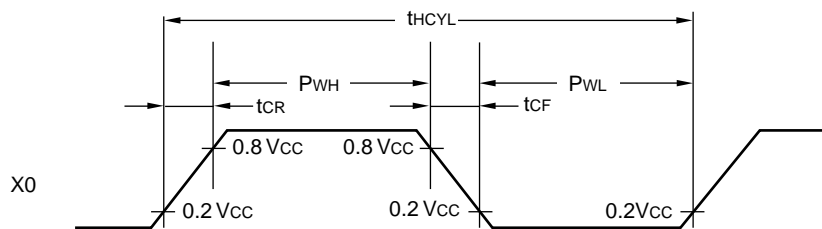
Main Clock Conditions

When using a crystal oscillator or ceramic oscillator
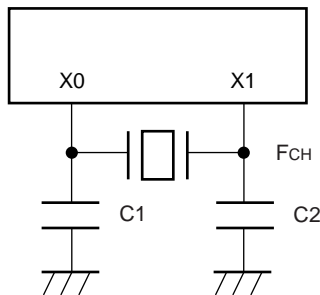
When using an external clock
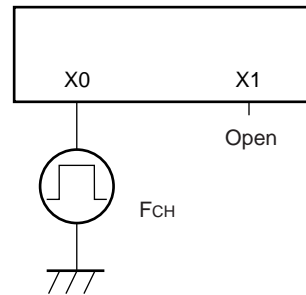
X0A and X1A Timing
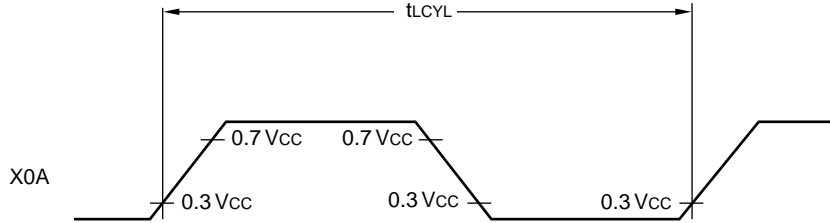
When using a crystal oscillator
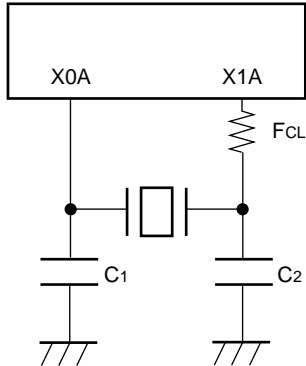
Note : External clock is not available.

(4) Instruction Cycle

$(AV_{SS} = V_{SS} = 0.0 \text{ V}, T_A = -40 \text{ °C to } +85 \text{ °C})$

Parameter	Symbol	Value	Unit	Remarks
Instruction cycle (minimum execution time)	t_{inst}	$4/F_{CH}, 8/F_{CH}, 16/F_{CH}, 64/F_{CH}$	µs	t_{inst} = 0.32 µs when operating at F_{CH} = 12.5 MHz (4/F_{CH})
		$2/F_{CL}$	µs	t_{inst} = 61.036 µs when operating at F_{CL} = 32.768 kHz

(5) Serial I/O Timing

$(V_{CC} = 5.0V, AV_{SS} = V_{SS} = 0.0\ V, T_A = -40\ °C\ to\ +85\ °C)$

Parameter	Symbol	Pin	Condition	Value Min	Value Max	Unit	Remarks
Serial clock cycle time	t_{SCYC}	SCK, SCK1, UCK	Internal shift clock mode	$2\ t_{inst}$*	—	µs	
SCK ↓ → SO time	t_{SLOV}	SCK, SO, SCK1, SO1, UCK, UO		–200	+200	ns	
Valid SI → SCK ↑	t_{IVSH}	SI, SCK, SI1, SCK1, UI, UCK		200	—	ns	
SCK ↑ → valid SI hold time	t_{SHIX}	SCK, SI, SCK1, SI1, UCK, UI		200	—	ns	
Serial clock "H" pulse width	t_{SHSL}	SCK, SCK1, UCK	External shift clock mode	$1\ t_{inst}$*	—	µs	
Serial clock "L" pulse width	t_{SLSH}			$1\ t_{inst}$*	—	µs	
SCK ↓ → SO time	t_{SLOV}	SCK, SO, SCK1, SO1, UCK, UO		0	200	ns	
Valid SI → SCK ↑	t_{IVSH}	SI, SCK, SI1, SCK1, UI, UCK		200	—	ns	
SCK ↑ → valid SI hold time	t_{SHIX}	SCK, SI, SCK1, SI1, UCK, UI		200	—	ns	

* : For information on t_{inst}, see "(4) Instruction Cycle."

Internal Shift Clock Mode / External Shift Clock Mode timing diagrams
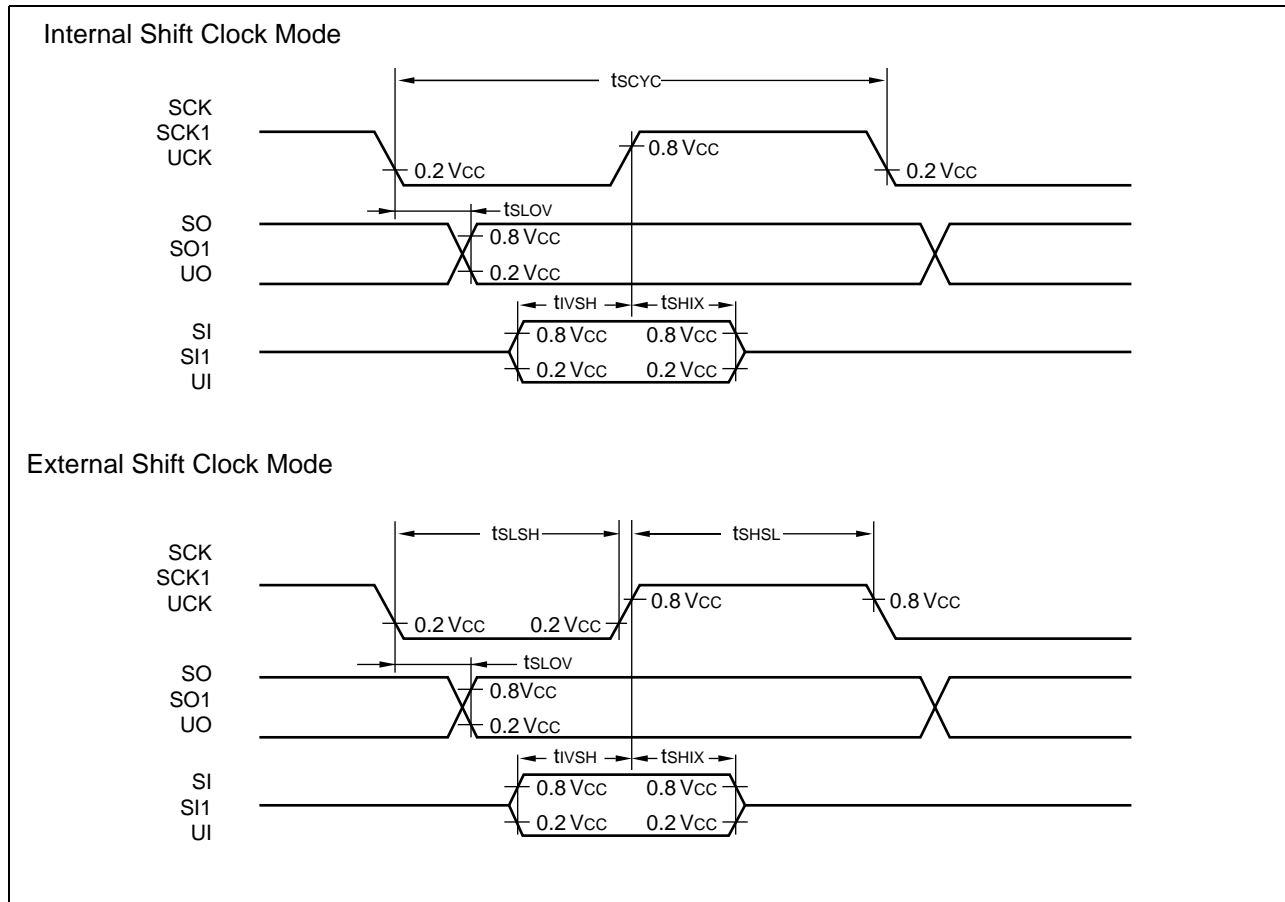
(6) Peripheral Input Timing

$(V_{CC} = 5.0V, AV_{SS} = V_{SS} = 0.0\ V, T_A = -40\ °C\ to\ +85\ °C)$

Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min	Max		
Peripheral input "H" pulse width 1	t_{ILIH1}	INT10 to INT17, $\overline{INT20}$ to $\overline{INT23}$, EC, PWC	—	$2\ t_{inst}$*	—	μs	
Peripheral input "L" pulse width 1	t_{IHIL1}		—	$2\ t_{inst}$*	—	μs	

* : For information on $t_{inst,}$ see "(4) Instruction Cycle."

(7) I²C timing

$(\text{Vcc} = 5.0 \text{ V}, \text{AV}_{SS} = \text{V}_{SS} = 0.0 \text{ V}, \text{T}_A = -40 \,°C \text{ to } +85 \,°C)$

Parameter	Symbol	Pin	Condition	Value Min	Value Max	Unit	Remarks
Start condition output	t_{STA}	SCL SDA	—	$1/4 \, t_{inst}$[*1] $\times$ $M^{*2} \times N^{*3}$ - 20	$1/4 \, t_{inst} \times$ $M^{*2} \times N^{*3}$ + 20	ns	Master mode
Stop condition output	t_{STO}	SCL SDA	—	$1/4 \, t_{inst} \times$ $(M^{*2} \times N^{*3}$ + 8) - 20	$1/4 \, t_{inst} \times$ $(M^{*2} \times N^{*3}$ + 8) + 20	ns	Master mode
Start condition detect	t_{STA}	SCL SDA	—	$1/4 \, t_{inst} \times 6$ + 40	—	ns	
Stop condition detect	t_{STO}	SCL SDA	—	$1/4 \, t_{inst} \times 6$ + 40	—	ns	
Re-start condition output	t_{STASU}	SCL SDA	—	$1/4 \, t_{inst} \times$ $(M^{*2} \times N^{*3}$ + 8) - 20	$1/4 \, t_{inst} \times$ $(M^{*2} \times N^{*3}$ + 8) + 20	ns	Master mode
Re-start condition detect	t_{STASU}	SCL SDA	—	$1/4 \, t_{inst} \times 4$ + 40	—	ns	
SCL output LOW width	t_{LOW}	SCL	—	$1/4 \, t_{inst} \times$ $M^{*2} \times N^{*3}$ - 20	$1/4 \, t_{inst} \times$ $M^{*2} \times N^{*3}$ + 20	ns	Master mode
SCL output HIGH width	t_{HIGH}	SCL	—	$1/4 \, t_{inst} \times$ $(M^{*2} \times N^{*3}$ + 8) - 20	$1/4 \, t_{inst} \times$ $(M^{*2} \times N^{*3}$ + 8) + 20	ns	Master mode
SDA output delay	t_{DO}	SDA	—	$1/4 \, t_{inst} \times 4$ - 20	$1/4 \, t_{inst} \times 4$ + 20	ns	
SDA output setup time after interrupt	t_{DOSU}	SDA	—	$1/4 \, t_{inst} \times 4$ - 20	—	ns	*4
SCL input LOW pulse width	t_{LOW}	SCL	—	$1/4 \, t_{inst} \times 6$ + 40	—	ns	
SCL input HIGH pulse width	t_{HIGH}	SCL	—	$1/4 \, t_{inst} \times 2$ + 40	—	ns	
SDA input setup time	t_{SU}	SDA	—	40	—	ns	
SDA hold time	t_{HO}	SDA	—	0	—	ns	

*1 : For information in t_{inst}, see " (4) Instruction Cycle".

*2 : M is defined in the ICCR CS4 and CS3 (bit 4 to bit 3) . For details, please refer to the H/W manual register explanation.

*3 : N is defined in the ICCR CS2 to CS0 (bit 2 to bit 0) .

*4 : When the interrupt period is greater than SCL "L" width, SDA and SCL output (Standard) value is based on hypothesis when rising time is 0 ns.

Data transmit (master/slave)

Data receive (master/slave)
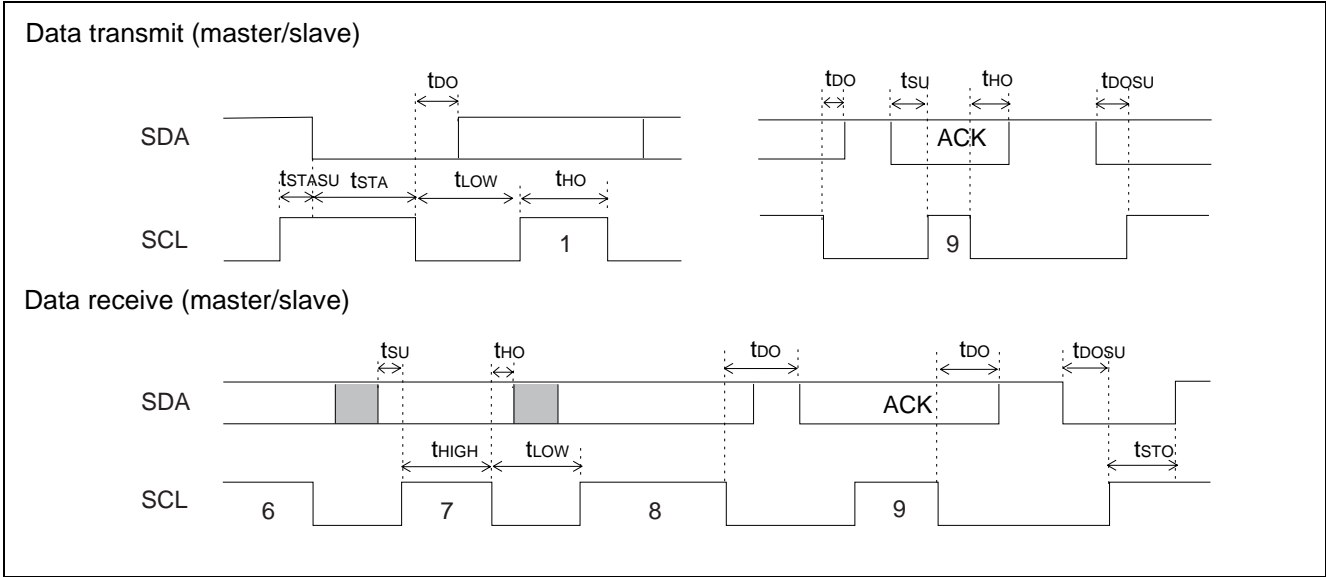
6. A/D Converter Electrical Characteristics

(1) For MB89567A/AC A/D Converter

(AVcc = 2.7 V to 5.5 V, AVss = Vss = 0.0 V, TA = −40 °C to +85 °C)

Parameter	Symbol	Pin	Condition	Value Min	Value Typ	Value Max	Unit	Remarks
Resolution	—	—	—	—	—	10	bit	
Total error			AVR=AVcc	—	—	±3.0	LSB	1LSB = AVR/1024
Non-linearity error				—	—	±2.5	LSB	
Differential linearity error				—	—	±1.9	LSB	
Zero transition voltage	V_{OT}			AVss – 1.5 LSB	AVss + 0.5 LSB	AVss + 2.5 LSB	mV	
Full-scale transition voltage	V_{FST}			AVR – 3.5 LSB	AVR – 1.5 LSB	AVR + 1.5 LSB	mV	
Interchannel disparity				—	—	4	LSB	1LSB = AVR/1024
A/D mode conversion time *3	—		—	—	60 t_{inst}*1	—	μs	
A/D Sampling time				—	16 t_{inst}*1	—		
Analog port input current	I_{AIN}	AN0 to AN7		—	—	10	μA	
Analog input voltage	V_{AIN}			AVss	—	AVR	V	
Power supply current	I_A	AVcc	—	—	4	6	mA	when A/D conversion is activated
	I_{AH}		TA = +25 °C	—	1	5	μA	when A/D conversion is stopped
Reference voltage	—	AVR	—	AVss+3.5	—	AVcc	V	
Reference voltage supply current	I_R		A/D is Activated	—	200	—	μA	
	I_{RH}		A/D is Stopped	—	—	5	μA	*2

*1 : For information on t_{inst}, see "(4) Instruction Cycle" in "5. AC Characteristics."

*2 : When A/D conversion is not in operation, and the CPU is in STOP mode.

*3 : Included sampling time

(2) For MB89P568/PV560 A/D Converter

(AVcc=3.5 V to 5.5 V, AV$_{SS}$ = V$_{SS}$ = 0.0 V, T$_A$ = −40 °C to +85 °C)

Parameter	Symbol	Pin	Condition	Value Min	Value Typ	Value Max	Unit	Remarks
Resolution	—	—	—	—	—	10	bit	1LSB = AVR/1024
Total error			AVR=AV$_{CC}$	—	—	±3.0	LSB	
Non-linearity error				—	—	±2.5	LSB	
Differential linearity error				—	—	±1.9	LSB	
Zero transition voltage	V$_{OT}$			AVss – 1.5 LSB	AVss + 0.5 LSB	AVss + 2.5 LSB	mV	
Full-scale transition voltage	V$_{FST}$			AVR – 3.5 LSB	AVR – 1.5 LSB	AVR + 1.5 LSB	mV	
Interchannel disparity				—	—	4	LSB	1LSB = AVR/1024
A/D mode conversion time *3	—		—	—	60 t$_{inst}$*1	—	µs	
A/D Sampling time				—	16 t$_{inst}$*1	—		
Analog port input current	I$_{AIN}$	AN0 to AN7		—	—	10	µA	
Analog input voltage	V$_{AIN}$			AVss	—	AVR	V	
Power supply current	I$_A$	AV$_{CC}$	—	—	4	6	mA	when A/D conversion is activated
	I$_{AH}$		T$_A$ = +25 °C	—	1	5	µA	when A/D conversion is stopped
Reference voltage	—	AVR	—	AVss + 3.5	—	AV$_{CC}$	V	
Reference voltage supply current	I$_R$		A/D is Activated	—	400	—	µA	
	I$_{RH}$		A/D is Stopped	—	—	5	µA	*2

*1 : For information on t$_{inst}$, see "(4) Instruction Cycle" in "5. AC Characteristics."

*2 : When A/D conversion is not in operation, and the CPU is in STOP mode.

*3 : Included sampling time

(3) A/D Converter Glossary
- Resolution
  Analog changes that are identifiable with the A/D converter.
- Linearity error
  The deviation of the straight line connecting the zero transition point ("00 0000 0000" ↔ "00 0000 0001") with the full-scale transition point ("11 1111 1110" ↔ "11 1111 1111") from actual conversion characteristics
- Differential linearity error
  The deviation of input voltage needed to change the output code by 1 LSB from the theoretical value
- Total error (unit: LSB)
  The difference between theoretical and actual conversion values caused by the zero transition error, full-scale transition error, linearity error, quantization error, and noise

Theoretical I/O characteristics

Total error

$$1\ \text{LSB} = \frac{V_{FST} - V_{OT}}{1022}\ \text{(V)}$$

$$\text{Total error for digital output N} = \frac{V_{NT} - \{1\ \text{LSB} \times N + 0.5\ \text{LSB}\}}{1\ \text{LSB}}$$
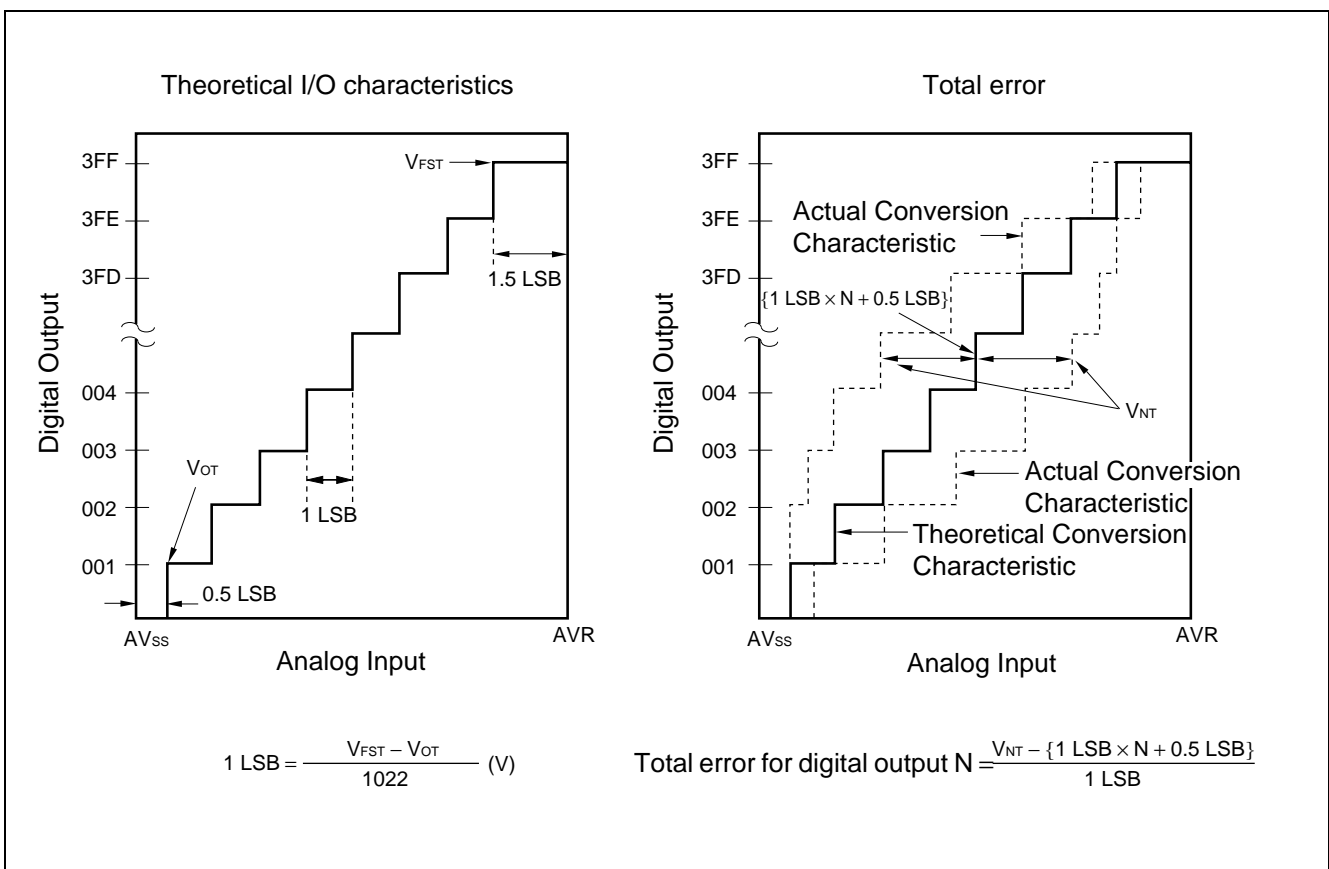
(Continued)

Zero transition error
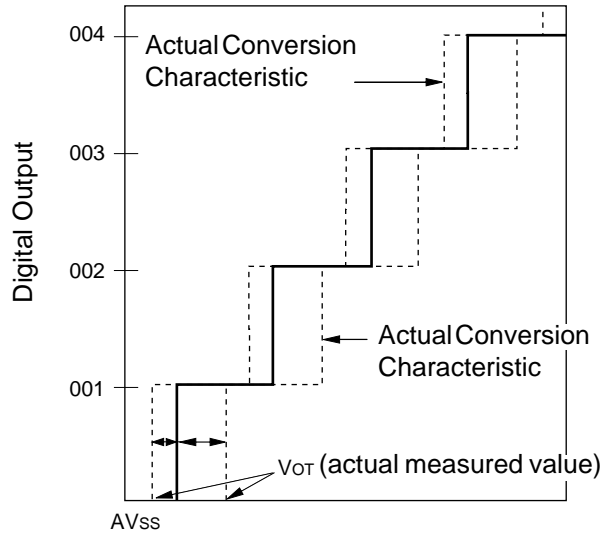
Full-scale transition error
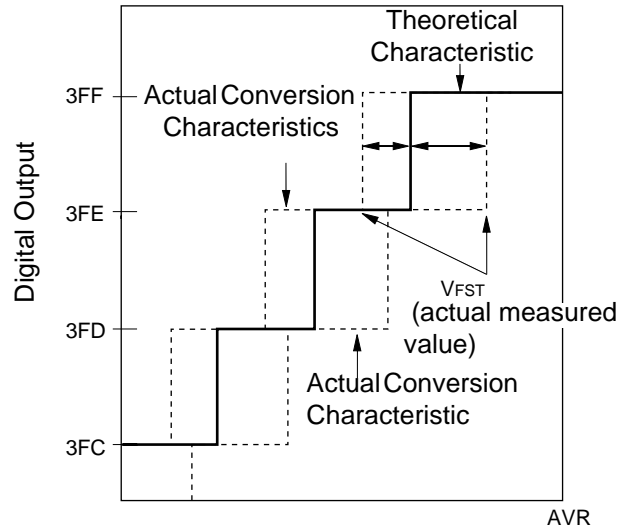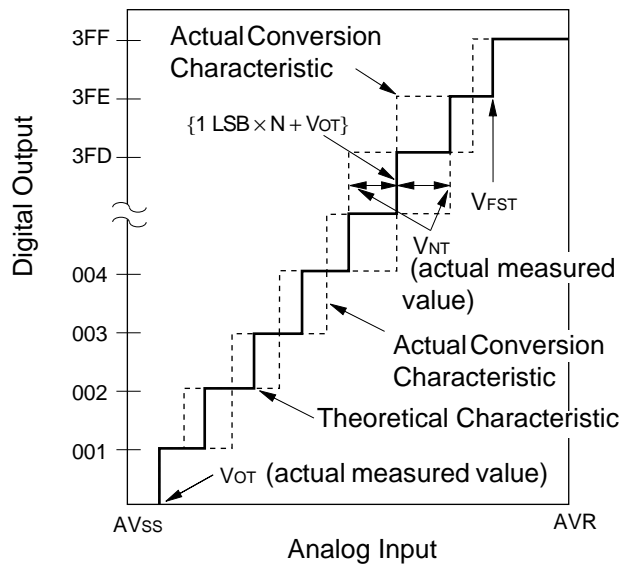
Linearity error

Differential linearity error
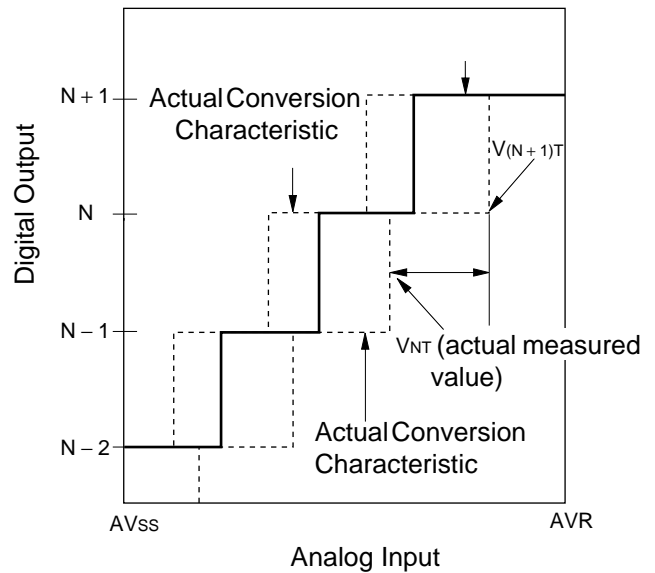
Linearity error in digital output $N = \dfrac{V_{NT} - \{1\ LSB \times N + 0.5\ LSB\}}{1\ LSB}$

Differential linearity error in digital output $N = \dfrac{V_{(N+1)T} - V_{NT}}{1\ LSB} - 1$

(4) Precautions
- The smaller the | AVR–AVss | is, the greater the error would become relatively.
- The output impedance of the external circuit for the analog input must satisfy the following conditions :
  Output impedance of the external circuit < Approx. 10 kΩ
- If the output impedance of the external circuit is too high, an analog voltage sampling time might be insufficient.

Analog Input equivalent circuit

Sample hold circuit *

C $\fallingdotseq$ 45 pF

Analog input pin

If the analog input impedance is higher than 10 kΩ, it is recommended to connect an external capacitor of approx. 0.1 μF.

Comparator

R $\fallingdotseq$ 2.2 kΩ

Close for 8 instruction cycles after starting A/D conversion.

Analog channel selector
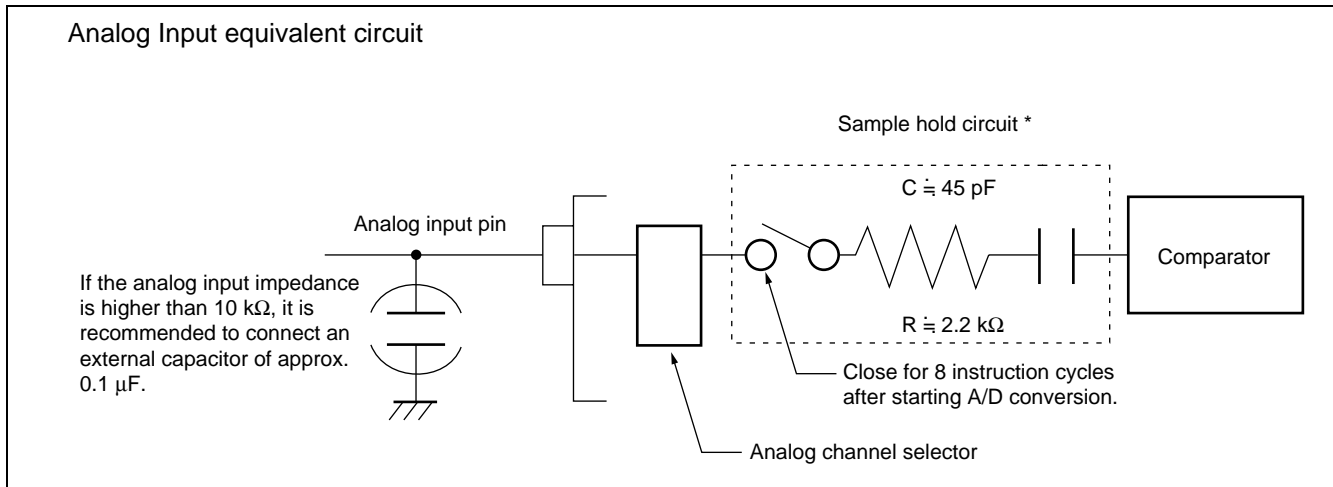
* : The value of R and C at the sample hold circuit depends on the following.
  MB89567A/MB89567AC : R $\fallingdotseq$ 2.2 kΩ, C $\fallingdotseq$ 45 pF
  MB89P568/MB89PV560 : R $\fallingdotseq$ 1.4 kΩ, C $\fallingdotseq$ 64 pF

■ EXAMPLE CHARACTERISTICS

(1) "L" Level Output Voltage

$V_{CC} - V_{OL1}$ vs. I_{OL}

V_{CC} = 2.5 V V_{CC} = 3.0 V V_{CC} = 4.0 V V_{CC} = 5.0 V
V_{CC} = 3.5 V V_{CC} = 4.5 V V_{CC} = 5.5 V
V_{CC} = 6.0 V
V_{CC} = 6.5 V

$V_{CC} - V_{OL1}$ (V)

I_{OL} (mA)

(2) "H" Level Output Voltage

$V_{CC} - V_{OH1}$ vs. I_{OH}

V_{CC} = 3.5 V
V_{CC} = 4.0 V
V_{CC} = 4.5 V
V_{CC} = 5.0 V
V_{CC} = 5.5 V
V_{CC} = 6.0 V
V_{CC} = 6.5 V

$V_{CC} - V_{OH1}$ (V)

I_{OH} (mA)
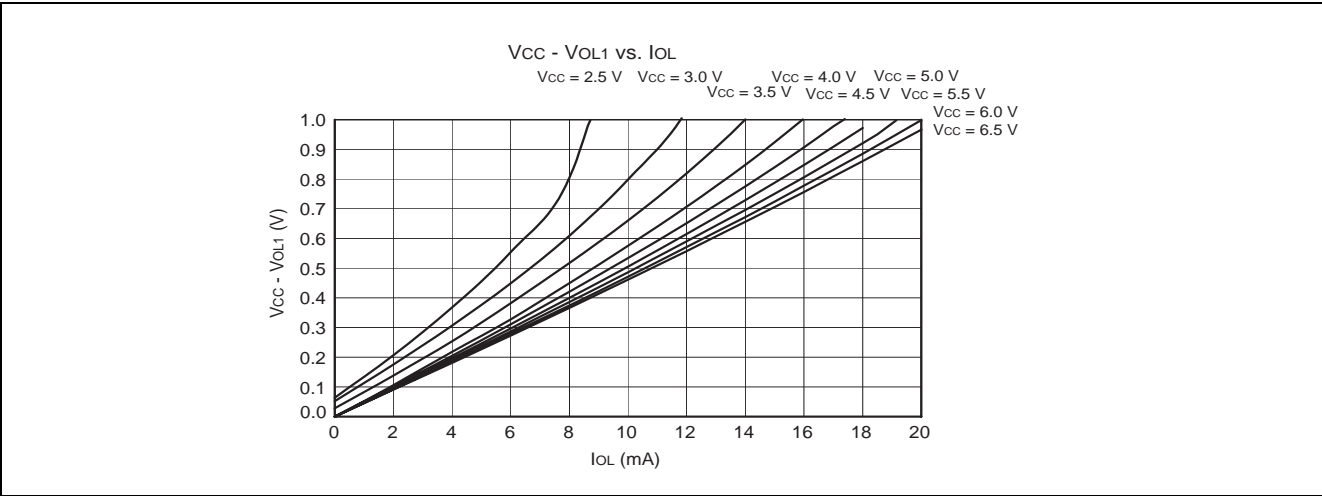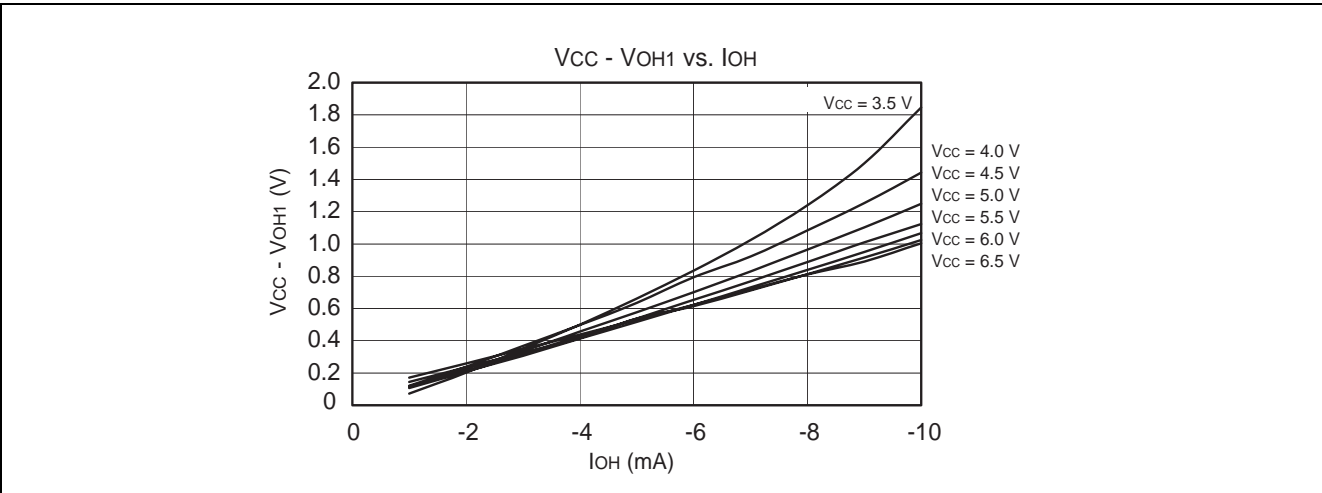
(3) "H" Level Input Voltage / "L" Level Input Voltage

CMOS input

$T_A = + 25 °C$

V_{IN} (V)

V_{CC} (V)

Hysteresis input

$T_A = + 25 °C$

V_{IHS}

V_{ILS}

V_{IN} (V)

V_{CC} (V)

V_{IHS} : Threshold when input voltage in hysteresis characteristics is set to "H" level.
V_{ILS} : Threshold when input voltage in hysteresis characteristics is set to "L" level.
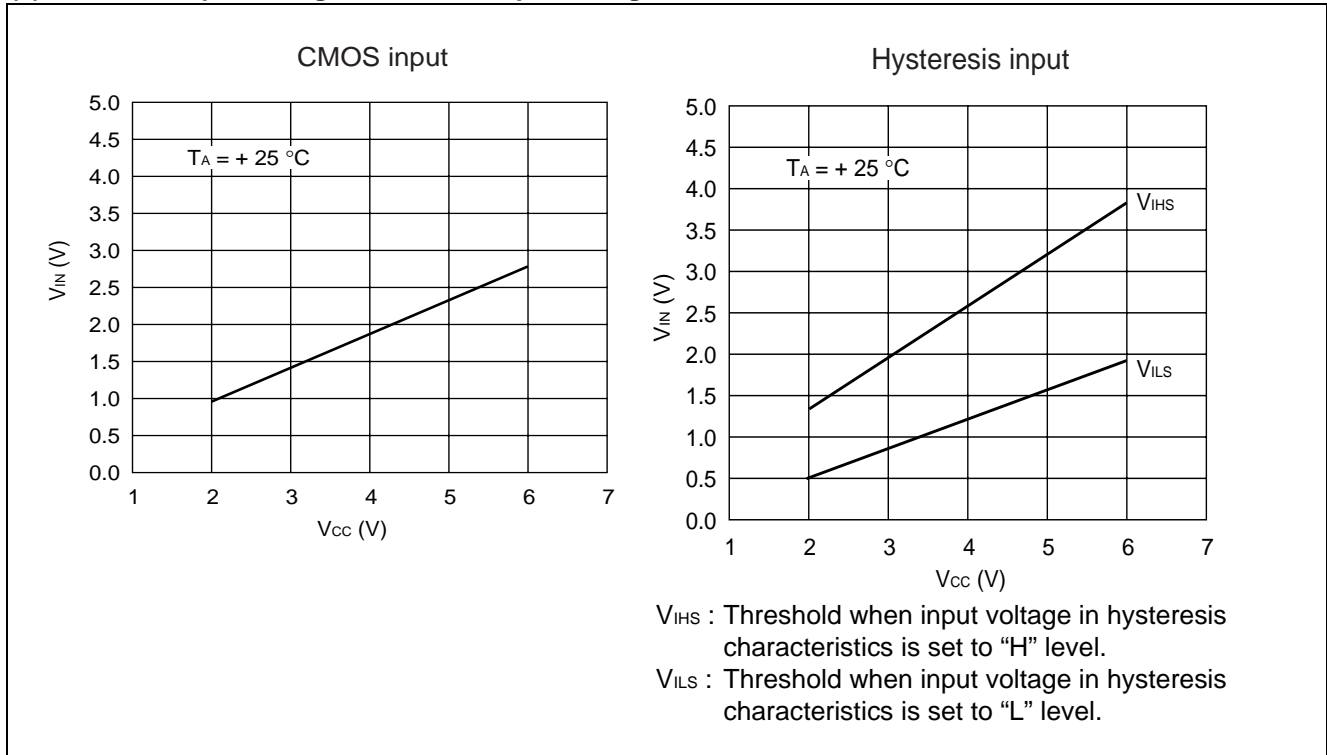
(4) Power Supply Current (External Clock)

I_{CC1} vs. V_{CC}
(Mask ROM products)

I_{CC2} vs. V_{CC}
(Mask ROM products)

I_{CCS1} vs. V_{CC}
(Mask ROM products)

I_{CCS2} vs. V_{CC}
(Mask ROM products)

I_{CCL} vs. V_{CC}
(Mask ROM products)

I_{CCT} vs. V_{CC}
(Mask ROM products)

(Continued)

MB89560A Series

(Continued)

ICCLS vs. VCC (Mask ROM products)

IA VS. AVCC

IR vs. AVR
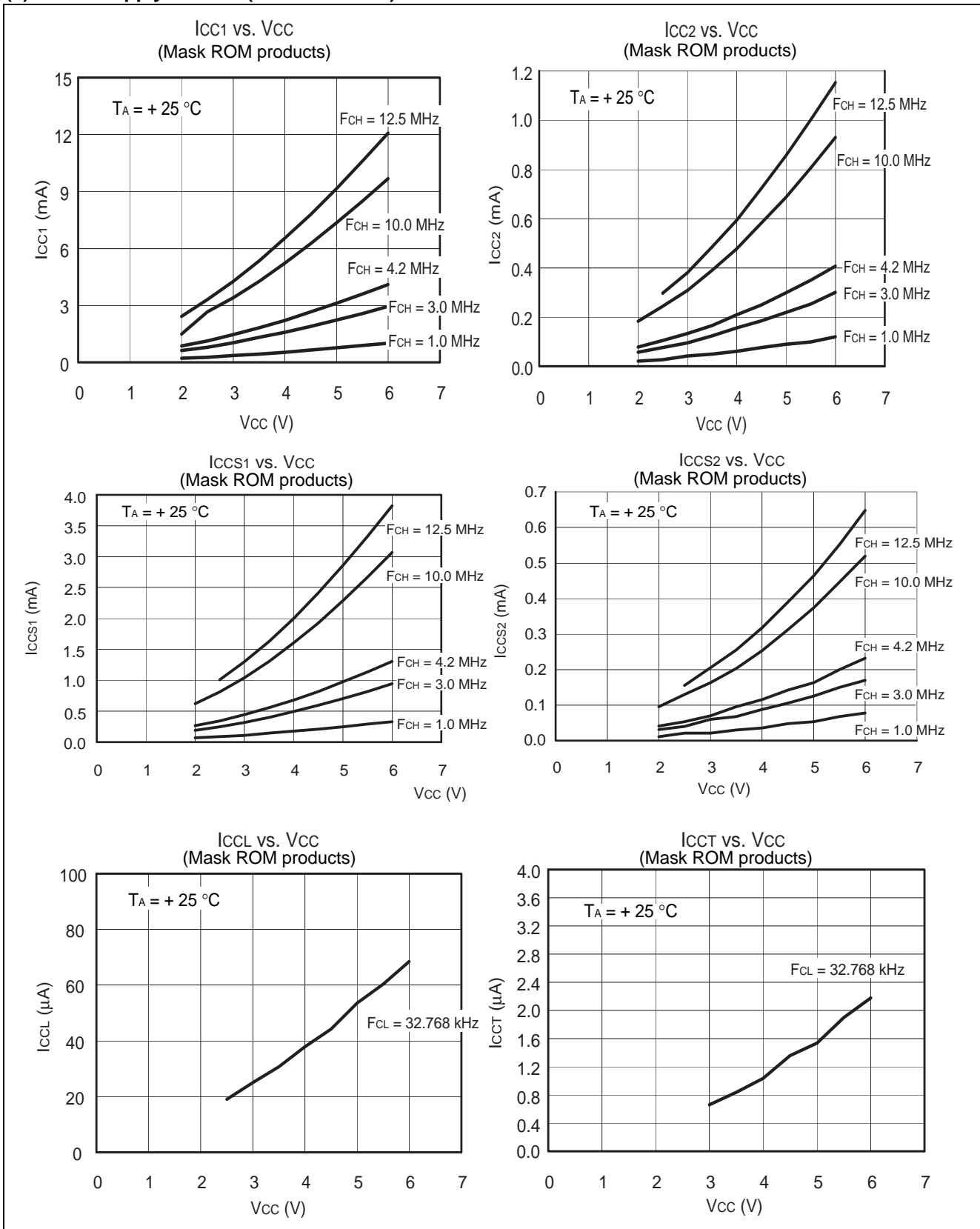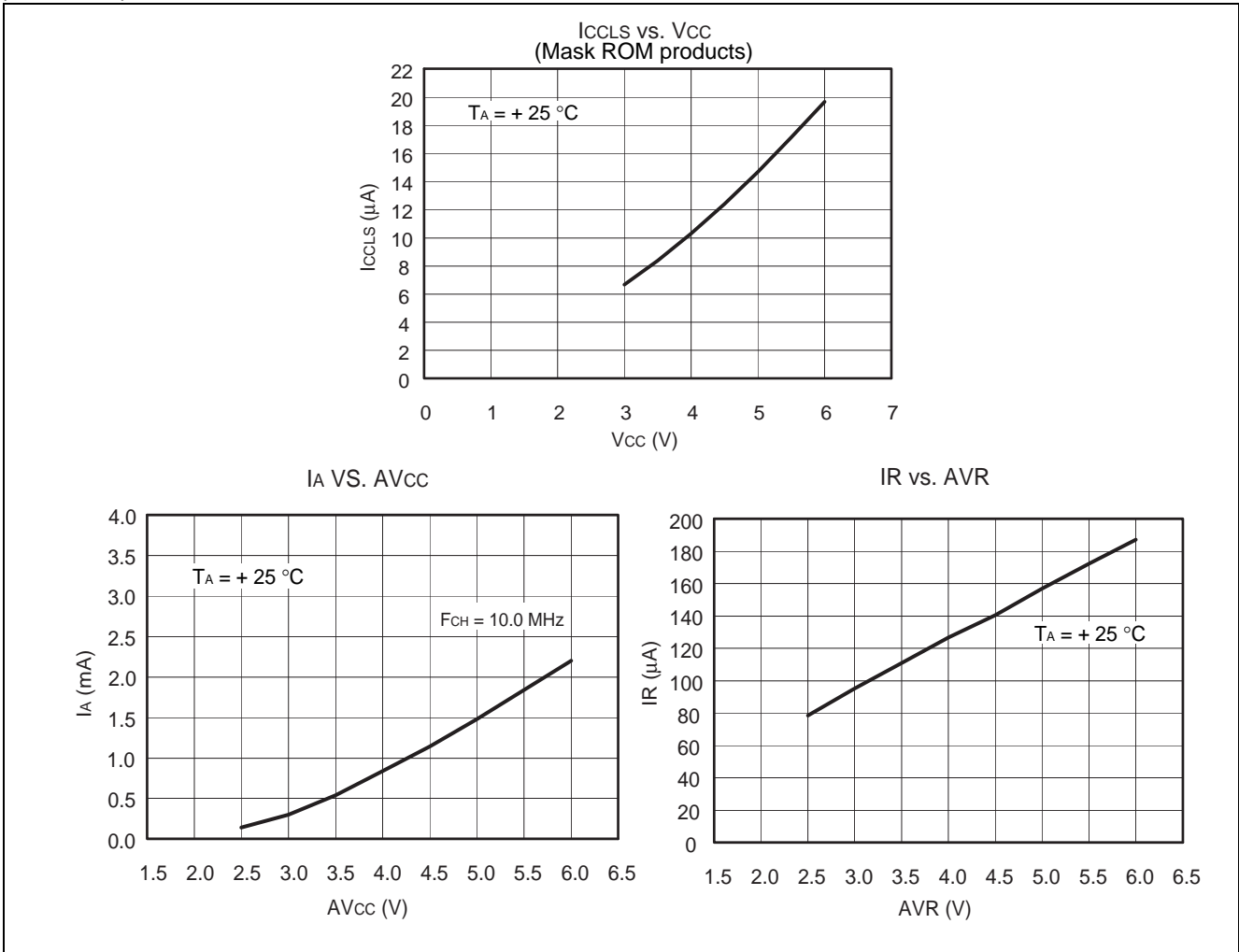
(5) Pull-up Resistance

Rpull vs.VCC
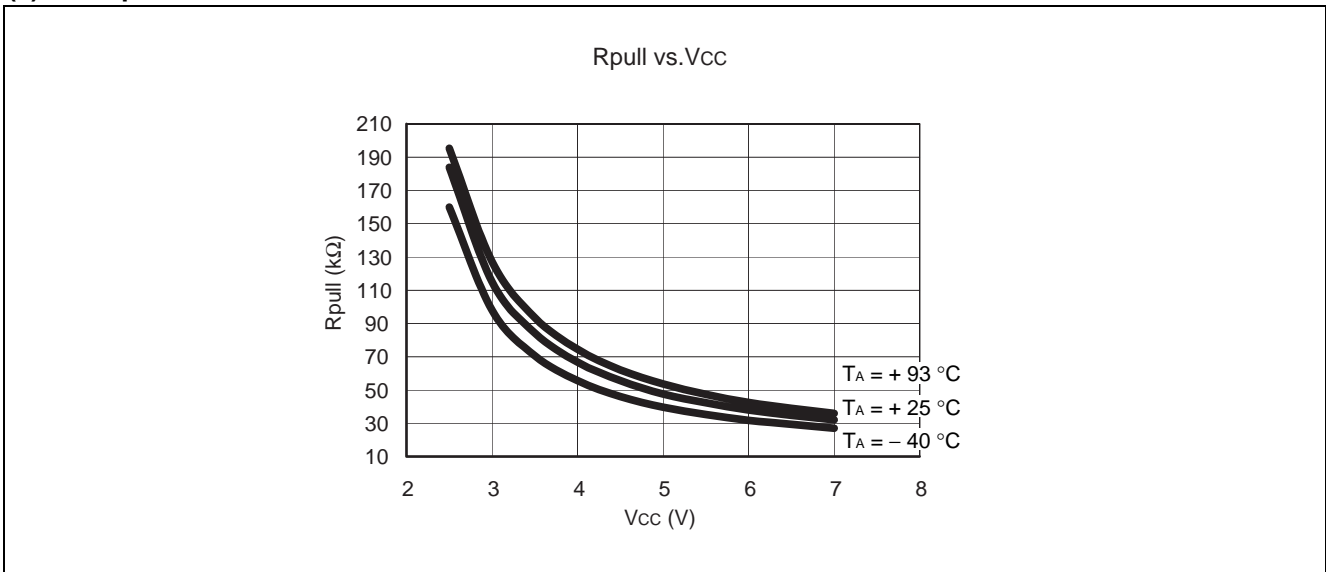
■ MASK OPTIONS

No.	Model	MB89567A MB89567AC	MB89P568	MB89PV560
	Specification method	Specify when ordering mask.	Setting unavailable.	Setting unavailable.
1	Main clock oscillation stabilization delay time initial value* selection (F_{CH} = 10 MHz) • 01: $2^{14}/F_{CH}$ (Approx. 1.6 ms) • 10: $2^{17}/F_{CH}$ (Approx. 13.1 ms) • 11: $2^{18}/F_{CH}$ (Approx. 26.2 ms)	Selectable	$2^{18}/F_{CH}$ (Approx. 26.2 ms)	$2^{18}/F_{CH}$ (approx. 26.2 ms)
2	LCD driving power supply • On-chip voltage booster • Internal voltage divider (external divider resistors can be used)	Selectable	-101 Internal voltage divider -102 On-chip voltage booster	-101 Internal voltage divider -102 On-chip voltage booster

■ ORDERING INFORMATION

Part number	Package	Remarks
MB89567APFV MB89567ACPFV MB89P568PFV-101	80-pin Plastic LQFP (FPT-80P-M05)	Without Booster Resistor divider
MB89567APFV MB89567ACPFV MB89P568PFV-102		With Booster
MB89567APF MB89567ACPF MB89P568PF-101	80-pin Plastic QFP (FPT-80P-M06)	Without Booster Resistor divider
MB89567APF MB89567ACPF MB89P568PF-102		With Booster
MB89567APFM MB89567ACPFM MB89P568PFM-101	80-pin Plastic LQFP (FPT-80P-M11)	Without Booster Resistor divider
MB89567APFM MB89567ACPFM MB89P568PFM-102		With Booster
MB89PV560CF-101	80-pin Ceramic MQFP (MQP-80C-P01)	Without Booster Resistor divider
MB89PV560CF-102		With Booster

■ PACKAGE DIMENSIONS

80-pin plastic LQFP
(FPT-80P-M05)

*Pins width and pins thickness include plating thickness.

14.00±0.20(.551±.008)SQ

12.00±0.10(.472±.004)SQ

0.145±0.055
(.006±.002)

60   41

61   40

0.08(.003)

INDEX

80   21

Details of "A" part

$1.50^{+0.20}_{-0.10}$ (Mounting height)
$(.059^{+.008}_{-.004})$

0°~8°

0.10±0.10
(.004±.004)
(Stand off)

0.50±0.20
(.020±.008)

0.25(.010)

0.60±0.15
(.024±.006)

LEAD No. 1   20

0.50(.020)

0.20±0.05
(.008±.002)   ⊕ 0.08(.003) Ⓜ

"A"
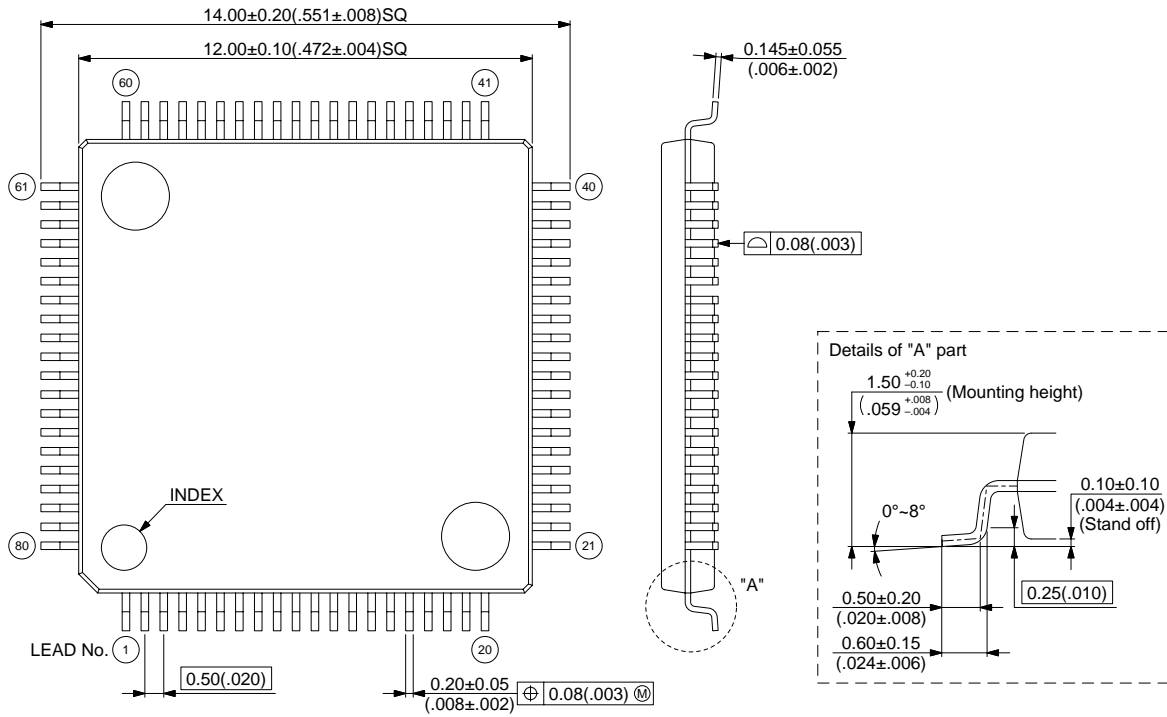
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Dimensions in mm (inches)

(Continued)

80-pin plastic QFP
(FPT-80P-M06)

*Pins width and pins thickness include plating thickness.

23.90±0.40(.941±.016)

20.00±0.20(.787±.008)

64

41

65

40

17.90±0.40
(.705±.016)

14.00±0.20
(.551±.008)

INDEX

80

25

1

24

0.80(.031)

0.37±0.05
(.015±.002)

$\oplus$ 0.20(.008) Ⓜ

0.10(.004)

0.17±0.06
(.007±.002)

"A"

Details of "A" part

$3.05 {}^{+0.30}_{-0.20}$
$\left(.120 {}^{+.012}_{-.008}\right)$
(Mounting height)

0.25(.010)

0~8°

0.80±0.20
(.031±.008)

0.88±0.15
(.035±.006)

$0.30 {}^{+0.10}_{-0.25}$
$\left(.012 {}^{+.004}_{-.010}\right)$
(Stand off)
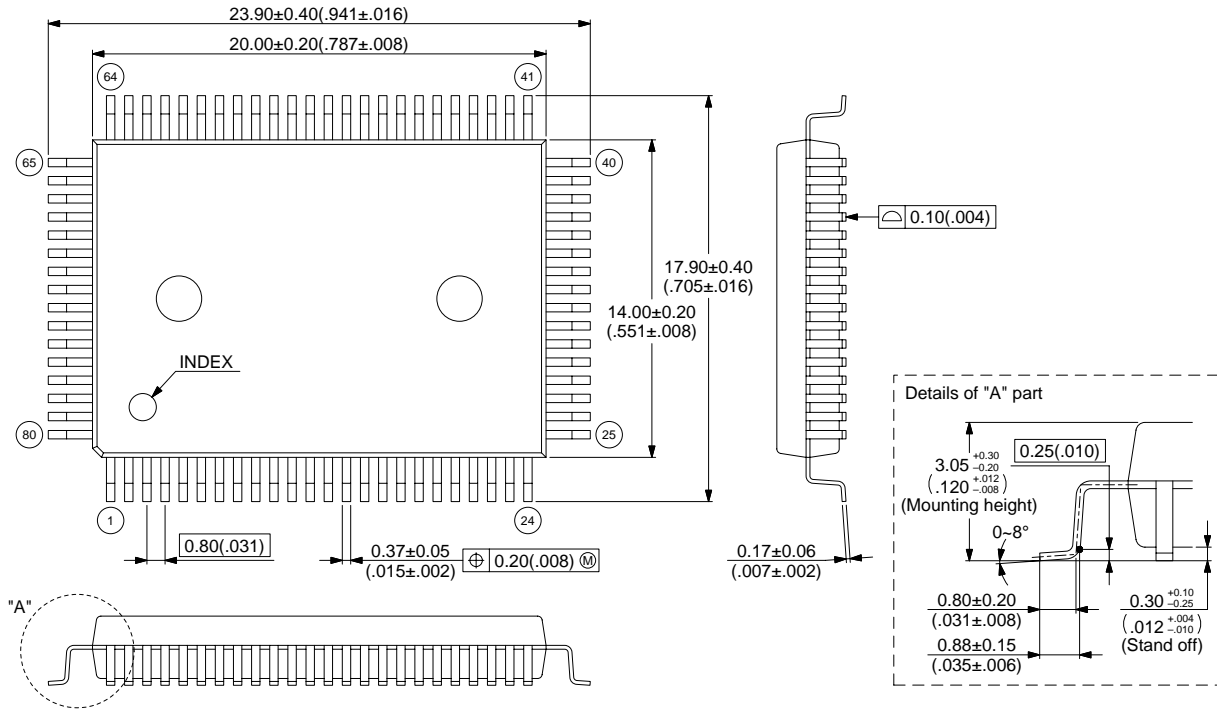
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Dimensions in mm (inches)

(Continued)

80-pin plastic LQFP
(FPT-80P-M11)

*Pins width and pins thickness include plating thickness.

16.00±0.20(.630±.008)SQ

14.00±0.10(.551±.004)SQ

0.145±0.055
(.006±.002)

0.10(.004)

INDEX

0.65(.026)

0.32±0.05
(.013±.002)

0.13(.005) M

"A"

Details of "A" part

$1.50^{+0.20}_{-0.10} \left(.059^{+.008}_{-.004} \right)$
(Mounting height)

0.25(.010)

0~8°

0.50±0.20
(.020±.008)

0.60±0.15
(.024±.006)

0.10±0.10
(.004±.004)
(Stand off)
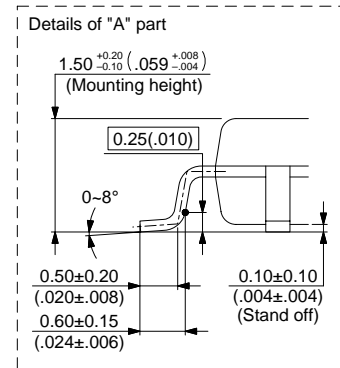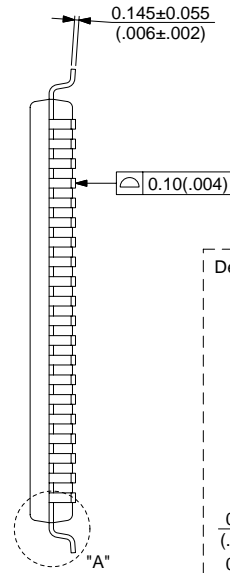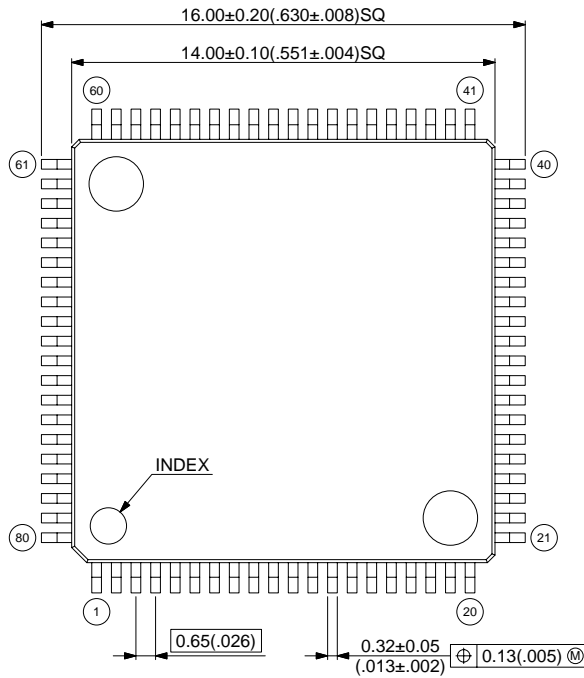
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Dimensions in mm (inches)

(Continued)

(Continued)

80-pin ceramic
(MQP-80C-P01)
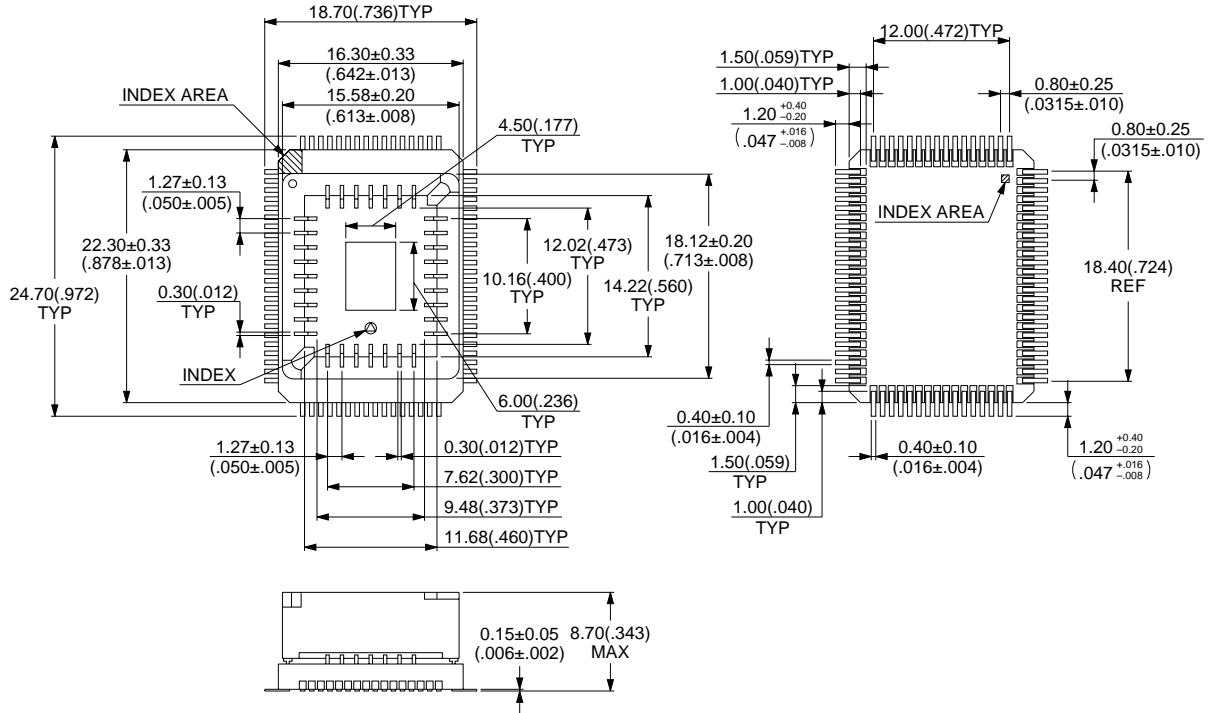
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Dimensions in mm (inches)

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